



# PCF8563

## Real-time clock/calendar

Rev. 11 — 26 October 2015

Product data sheet

## 1. General description

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The PCF8563 is a CMOS<sup>1</sup> Real-Time Clock (RTC) and calendar optimized for low power consumption. A programmable clock output, interrupt output, and voltage-low detector are also provided. All addresses and data are transferred serially via a two-line bidirectional I<sup>2</sup>C-bus. Maximum bus speed is 400 kbit/s. The register address is incremented automatically after each written or read data byte.

## 2. Features and benefits

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- Provides year, month, day, weekday, hours, minutes, and seconds based on a 32.768 kHz quartz crystal
- Century flag
- Clock operating voltage: 1.0 V to 5.5 V at room temperature
- Low backup current; typical 0.25  $\mu$ A at  $V_{DD} = 3.0$  V and  $T_{amb} = 25$  °C
- 400 kHz two-wire I<sup>2</sup>C-bus interface (at  $V_{DD} = 1.8$  V to 5.5 V)
- Programmable clock output for peripheral devices (32.768 kHz, 1.024 kHz, 32 Hz, and 1 Hz)
- Alarm and timer functions
- Integrated oscillator capacitor
- Internal Power-On Reset (POR)
- I<sup>2</sup>C-bus slave address: read A3h and write A2h
- Open-drain interrupt pin

## 3. Applications

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- Mobile telephones
- Portable instruments
- Electronic metering
- Battery powered products

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1. The definition of the abbreviations and acronyms used in this data sheet can be found in [Section 18](#).



## 4. Ordering information

Table 1. Ordering information

| Type number                | Package |  |          |
|----------------------------|---------|--|----------|
|                            | Name    | Description  | Version  |
| PCF8563BS/4                | HVSON10 | plastic thermal enhanced very thin small outline package; no leads; 10 terminals; body 3 × 3 × 0.85 mm | SOT650-1 |
| PCF8563T/5                 | SO8     | plastic small outline package; 8 leads; body width 3.9 mm  | SOT96-1  |
| PCF8563T/F4 <sup>[1]</sup> | SO8     | plastic small outline package; 8 leads; body width 3.9 mm  | SOT96-1  |
| PCF8563TS/4 <sup>[2]</sup> | TSSOP8  | plastic thin shrink small outline package; 8 leads; body width 3 mm                                    | SOT505-1 |
| PCF8563TS/5                | TSSOP8  | plastic thin shrink small outline package; 8 leads; body width 3 mm                                    | SOT505-1 |

[1] Not recommended for new designs. Replacement part is PCF8563T/5.

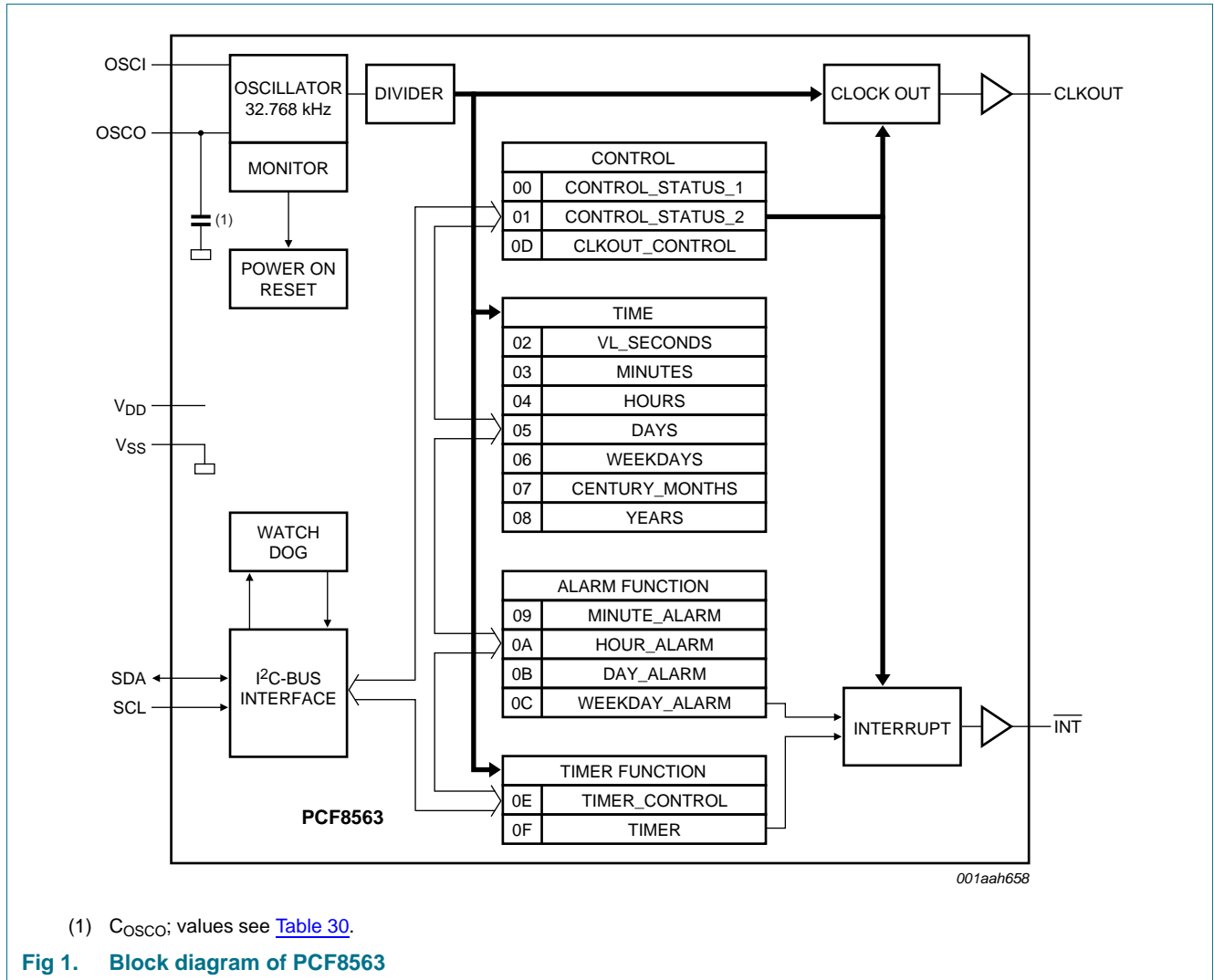
[2] Not recommended for new designs. Replacement part is PCF8563TS/5.

## 5. Marking

Table 2. Marking codes

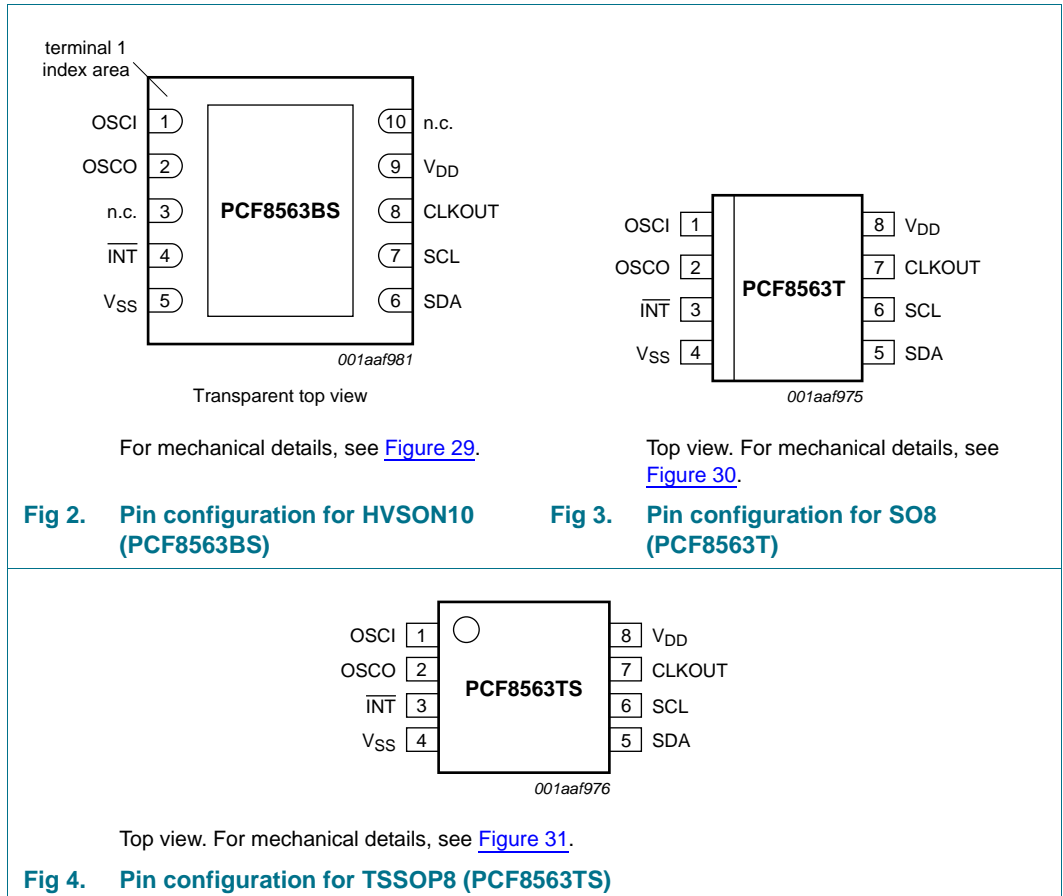
| Type number | Marking code |
|-------------|--------------|
| PCF8563BS/4 | 8563S        |
| PCF8563T/5  | PCF8563      |
| PCF8563T/F4 | 8563T        |
| PCF8563TS/4 | 8563         |
| PCF8563TS/5 | P8563        |

### 6. Block diagram



## 7. Pinning information

### 7.1 Pinning



## 7.2 Pin description

Table 3. Pin description

| Symbol                  | Pin         |                  | Description  |
|-------------------------|-------------|------------------|--|
|                         | SO8, TSSOP8 | HVSON10          |  |
| OSCI                    | 1           | 1                | oscillator input   |
| OSCO                    | 2           | 2                | oscillator output  |
| $\overline{\text{INT}}$ | 3           | 4                | interrupt output (open-drain; active LOW)                    |
| $V_{SS}$                | 4           | 5 <sup>[1]</sup> | ground   |
| SDA                     | 5           | 6                | serial data input and output                                 |
| SCL                     | 6           | 7                | serial clock input   |
| CLKOUT                  | 7           | 8                | clock output, open-drain                                     |
| $V_{DD}$                | 8           | 9                | supply voltage   |
| n.c.                    | -           | 3, 10            | not connected; do not connect and do not use as feed through |

- [1] The die paddle (exposed pad) is connected to  $V_{SS}$  through high ohmic (non-conductive) silicon attach and should be electrically isolated. It is good engineering practice to solder the exposed pad to an electrically isolated PCB copper pad for better heat transfer but it is not required as the RTC doesn't consume much power. In no case should traces be run under the package exposed pad.

## 8. Functional description

The PCF8563 contains sixteen 8-bit registers with an auto-incrementing register address, an on-chip 32.768 kHz oscillator with one integrated capacitor, a frequency divider which provides the source clock for the Real-Time Clock (RTC) and calendar, a programmable clock output, a timer, an alarm, a voltage-low detector, and a 400 kHz I<sup>2</sup>C-bus interface.

All 16 registers are designed as addressable 8-bit parallel registers although not all bits are implemented. The first two registers (memory address 00h and 01h) are used as control and/or status registers. The memory addresses 02h through 08h are used as counters for the clock function (seconds up to years counters). Address locations 09h through 0Ch contain alarm registers which define the conditions for an alarm. Address 0Dh controls the CLKOUT output frequency. 0Eh and 0Fh are the Timer\_control and Timer registers, respectively.

The Seconds, Minutes, Hours, Days, Months, Years as well as the Minute\_alarm, Hour\_alarm, and Day\_alarm registers are all coded in Binary Coded Decimal (BCD) format.

When one of the RTC registers is written or read, the contents of all time counters are frozen. Therefore, faulty writing or reading of the clock and calendar during a carry condition is prevented.

### 8.1 CLKOUT output

A programmable square wave is available at the CLKOUT pin. Operation is controlled by the register CLKOUT\_control at address 0Dh. Frequencies of 32.768 kHz (default), 1.024 kHz, 32 Hz, and 1 Hz can be generated for use as a system clock, microcontroller clock, input to a charge pump, or for calibration of the oscillator. CLKOUT is an open-drain output and enabled at power-on. If disabled it becomes high-impedance.

### 8.2 Register organization

**Table 4. Formatted registers overview**

Bit positions labelled as x are not relevant. Bit positions labelled with N should always be written with logic 0; if read they could be either logic 0 or logic 1. After reset, all registers are set according to [Table 27](#).

| Address                             | Register name    | Bit             |                   |                 |                  |       |                   |     |     |
|-------------------------------------|------------------|-----------------|-------------------|-----------------|------------------|-------|-------------------|-----|-----|
|                                     |                  | 7               | 6                 | 5               | 4                | 3     | 2                 | 1   | 0   |
| <b>Control and status registers</b> |                  |                 |                   |                 |                  |       |                   |     |     |
| 00h                                 | Control_status_1 | TEST1           | N                 | STOP            | N                | TESTC | N                 | N   | N   |
| 01h                                 | Control_status_2 | N               | N                 | N               | TI_TP            | AF    | TF                | AIE | TIE |
| <b>Time and date registers</b>      |                  |                 |                   |                 |                  |       |                   |     |     |
| 02h                                 | VL_seconds       | VL              | SECONDS (0 to 59) |                 |                  |       |                   |     |     |
| 03h                                 | Minutes          | x               | MINUTES (0 to 59) |                 |                  |       |                   |     |     |
| 04h                                 | Hours            | x               | x                 | HOURS (0 to 23) |                  |       |                   |     |     |
| 05h                                 | Days             | x               | x                 | DAYS (1 to 31)  |                  |       |                   |     |     |
| 06h                                 | Weekdays         | x               | x                 | x               | x                | x     | WEEKDAYS (0 to 6) |     |     |
| 07h                                 | Century_months   | C               | x                 | x               | MONTHS (1 to 12) |       |                   |     |     |
| 08h                                 | Years            | YEARS (0 to 99) |                   |                 |                  |       |                   |     |     |

**Table 4. Formatted registers overview ...continued**

Bit positions labelled as x are not relevant. Bit positions labelled with N should always be written with logic 0; if read they could be either logic 0 or logic 1. After reset, all registers are set according to [Table 27](#).

| Address                        | Register name  | Bit        |                        |                      |   |   |                        |         |   |
|--------------------------------|----------------|------------|------------------------|----------------------|---|---|------------------------|---------|---|
|                                |                | 7          | 6                      | 5                    | 4 | 3 | 2                      | 1       | 0 |
| <b>Alarm registers</b>         |                |            |                        |                      |   |   |                        |         |   |
| 09h                            | Minute_alarm   | AE_M       | MINUTE_ALARM (0 to 59) |                      |   |   |                        |         |   |
| 0Ah                            | Hour_alarm     | AE_H       | x                      | HOUR_ALARM (0 to 23) |   |   |                        |         |   |
| 0Bh                            | Day_alarm      | AE_D       | x                      | DAY_ALARM (1 to 31)  |   |   |                        |         |   |
| 0Ch                            | Weekday_alarm  | AE_W       | x                      | x                    | x | x | WEEKDAY_ALARM (0 to 6) |         |   |
| <b>CLKOUT control register</b> |                |            |                        |                      |   |   |                        |         |   |
| 0Dh                            | CLKOUT_control | FE         | x                      | x                    | x | x | x                      | FD[1:0] |   |
| <b>Timer registers</b>         |                |            |                        |                      |   |   |                        |         |   |
| 0Eh                            | Timer_control  | TE         | x                      | x                    | x | x | x                      | TD[1:0] |   |
| 0Fh                            | Timer          | TIMER[7:0] |                        |                      |   |   |                        |         |   |

### 8.3 Control registers

#### 8.3.1 Register Control\_status\_1

**Table 5. Control\_status\_1 - control and status register 1 (address 00h) bit description**

| Bit    | Symbol | Value              | Description  | Reference                      |
|--------|--------|--------------------|--|--------------------------------|
| 7      | TEST1  | 0 <sup>[1]</sup>   | normal mode<br>must be set to logic 0 during normal operations   | <a href="#">Section 8.9</a>    |
|        |        | 1                  | EXT_CLK test mode  |                                |
| 6      | N      | 0 <sup>[2]</sup>   | unused   |                                |
| 5      | STOP   | 0 <sup>[1]</sup>   | RTC source clock runs  | <a href="#">Section 8.10</a>   |
|        |        | 1                  | all RTC divider chain flip-flops are asynchronously set to logic 0; the RTC clock is stopped (CLKOUT at 32.768 kHz is still available) |                                |
| 4      | N      | 0 <sup>[2]</sup>   | unused   |                                |
| 3      | TESTC  | 0                  | Power-On Reset (POR) override facility is disabled; set to logic 0 for normal operation  | <a href="#">Section 8.11.1</a> |
|        |        | 1 <sup>[1]</sup>   | Power-On Reset (POR) override may be enabled   |                                |
| 2 to 0 | N      | 000 <sup>[2]</sup> | unused   |                                |

[1] Default value.

[2] Bits labeled as N should always be written with logic 0.

#### 8.3.2 Register Control\_status\_2

**Table 6. Control\_status\_2 - control and status register 2 (address 01h) bit description**

| Bit    | Symbol | Value              | Description   | Reference   |
|--------|--------|--------------------|---|---|
| 7 to 5 | N      | 000 <sup>[1]</sup> | unused  |   |
| 4      | TI_TP  | 0 <sup>[2]</sup>   | $\overline{\text{INT}}$ is active when TF is active (subject to the status of TIE)  | <a href="#">Section 8.3.2.1</a><br>and<br><a href="#">Section 8.8</a> |
|        |        | 1                  | $\overline{\text{INT}}$ pulses active according to <a href="#">Table 7</a> (subject to the status of TIE);<br><b>Remark:</b> note that if AF and AIE are active then $\overline{\text{INT}}$ will be permanently active |   |

Table 6. Control\_status\_2 - control and status register 2 (address 01h) bit description ...continued

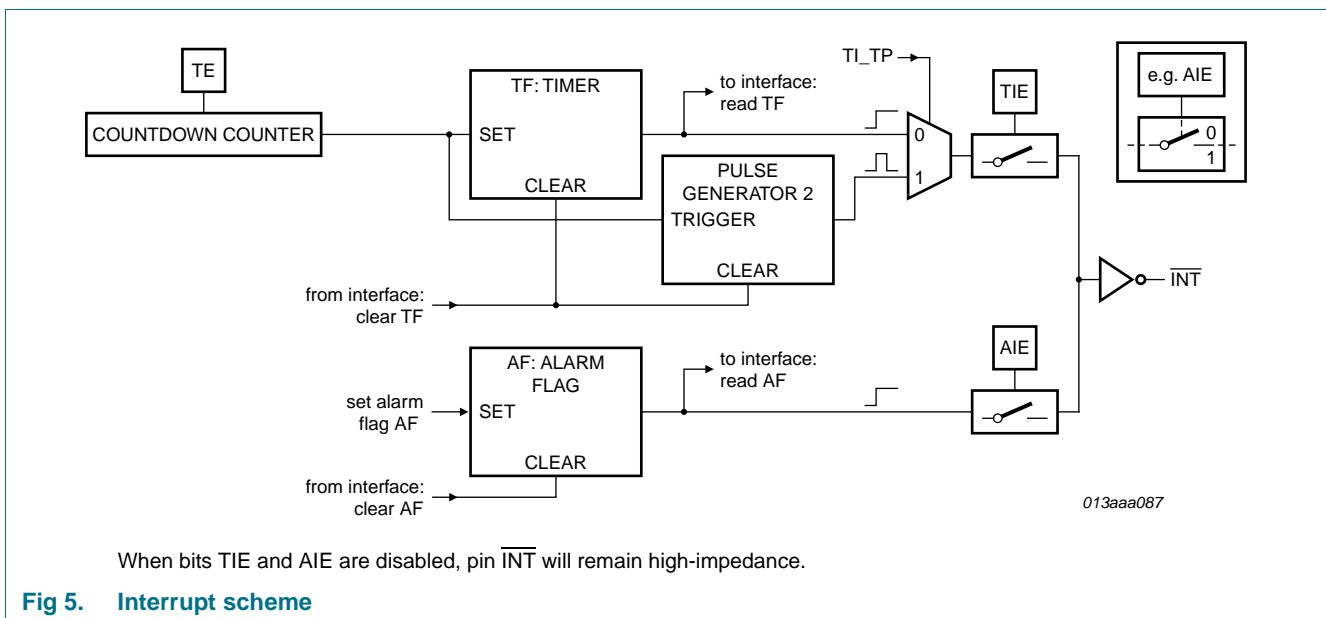
| Bit | Symbol | Value            | Description                         | Reference       |
|-----|--------|------------------|-------------------------------------|-----------------|
| 3   | AF     | 0 <sup>[2]</sup> | read: alarm flag inactive           | Section 8.3.2.1 |
|     |        |                  | write: alarm flag is cleared        |                 |
|     |        | 1                | read: alarm flag active             |                 |
|     |        |                  | write: alarm flag remains unchanged |                 |
| 2   | TF     | 0 <sup>[2]</sup> | read: timer flag inactive           |                 |
|     |        |                  | write: timer flag is cleared        |                 |
|     |        | 1                | read: timer flag active             |                 |
|     |        |                  | write: timer flag remains unchanged |                 |
| 1   | AIE    | 0 <sup>[2]</sup> | alarm interrupt disabled            |                 |
|     |        | 1                | alarm interrupt enabled             |                 |
| 0   | TIE    | 0 <sup>[2]</sup> | timer interrupt disabled            |                 |
|     |        | 1                | timer interrupt enabled             |                 |

[1] Bits labeled as N should always be written with logic 0.

[2] Default value.

8.3.2.1 Interrupt output

**Bits TF and AF:** When an alarm occurs, AF is set to logic 1. Similarly, at the end of a timer countdown, TF is set to logic 1. These bits maintain their value until overwritten using the interface. If both timer and alarm interrupts are required in the application, the source of the interrupt can be determined by reading these bits. To prevent one flag being overwritten while clearing another, a logic AND is performed during a write access.



When bits TIE and AIE are disabled, pin  $\overline{INT}$  will remain high-impedance.

Fig 5. Interrupt scheme

**Bits TIE and AIE:** These bits activate or deactivate the generation of an interrupt when TF or AF is asserted, respectively. The interrupt is the logical OR of these two conditions when both AIE and TIE are set.



**Countdown timer interrupts:** The pulse generator for the countdown timer interrupt uses an internal clock and is dependent on the selected source clock for the countdown timer and on the countdown value n. As a consequence, the width of the interrupt pulse varies (see [Table 7](#)).

**Table 7.**  $\overline{\text{INT}}$  operation (bit  $\text{TI\_TP} = 1$ )<sup>[1]</sup>

| Source clock (Hz) | $\overline{\text{INT}}$ period (s) |                      |
|-------------------|------------------------------------|----------------------|
|                   | n = 1 <sup>[2]</sup>               | n > 1 <sup>[2]</sup> |
| 4096              | $\frac{1}{8192}$                   | $\frac{1}{4096}$     |
| 64                | $\frac{1}{128}$                    | $\frac{1}{64}$       |
| 1                 | $\frac{1}{64}$                     | $\frac{1}{64}$       |
| $\frac{1}{60}$    | $\frac{1}{64}$                     | $\frac{1}{64}$       |

[1] TF and  $\overline{\text{INT}}$  become active simultaneously.

[2] n = loaded countdown value. Timer stops when n = 0.

## 8.4 Time and date registers

The majority of the registers are coded in the BCD format to simplify application use.

### 8.4.1 Register VL\_seconds

**Table 8.** VL\_seconds - seconds and clock integrity status register (address 02h) bit description

| Bit    | Symbol  | Value            | Place value | Description   |
|--------|---------|------------------|-------------|---|
| 7      | VL      | 0                | -           | clock integrity is guaranteed                                   |
|        |         | 1 <sup>[1]</sup> | -           | integrity of the clock information is not guaranteed            |
| 6 to 4 | SECONDS | 0 to 5           | ten's place | actual seconds coded in BCD format, see <a href="#">Table 9</a> |
| 3 to 0 |         | 0 to 9           | unit place  |   |

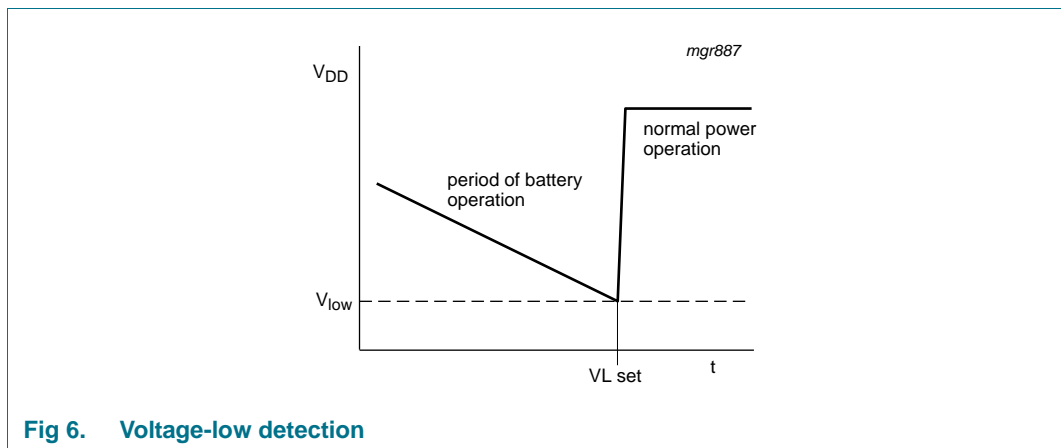
[1] Start-up value.

**Table 9.** Seconds coded in BCD format

| Seconds value (decimal) | Upper-digit (ten's place) |       |       | Digit (unit place) |       |       |       |
|-------------------------|---------------------------|-------|-------|--------------------|-------|-------|-------|
|                         | Bit 6                     | Bit 5 | Bit 4 | Bit 3              | Bit 2 | Bit 1 | Bit 0 |
| 00                      | 0                         | 0     | 0     | 0                  | 0     | 0     | 0     |
| 01                      | 0                         | 0     | 0     | 0                  | 0     | 0     | 1     |
| 02                      | 0                         | 0     | 0     | 0                  | 0     | 1     | 0     |
| :                       | :                         | :     | :     | :                  | :     | :     | :     |
| 09                      | 0                         | 0     | 0     | 1                  | 0     | 0     | 1     |
| 10                      | 0                         | 0     | 1     | 0                  | 0     | 0     | 0     |
| :                       | :                         | :     | :     | :                  | :     | :     | :     |
| 58                      | 1                         | 0     | 1     | 1                  | 0     | 0     | 0     |
| 59                      | 1                         | 0     | 1     | 1                  | 0     | 0     | 1     |

8.4.1.1 Voltage-low detector and clock monitor

The PCF8563 has an on-chip voltage-low detector (see Figure 6). When  $V_{DD}$  drops below  $V_{low}$ , bit VL in the VL\_seconds register is set to indicate that the integrity of the clock information is no longer guaranteed. The VL flag can only be cleared by using the interface.



The VL flag is intended to detect the situation when  $V_{DD}$  is decreasing slowly, for example under battery operation. Should the oscillator stop or  $V_{DD}$  reach  $V_{low}$  before power is re-asserted, then the VL flag is set. This will indicate that the time may be corrupted.

8.4.2 Register Minutes

Table 10. Minutes - minutes register (address 03h) bit description

| Bit    | Symbol  | Value  | Place value | Description                        |
|--------|---------|--------|-------------|------------------------------------|
| 7      | -       | -      | -           | unused                             |
| 6 to 4 | MINUTES | 0 to 5 | ten's place | actual minutes coded in BCD format |
| 3 to 0 |         | 0 to 9 | unit place  |                                    |

8.4.3 Register Hours

Table 11. Hours - hours register (address 04h) bit description

| Bit    | Symbol | Value  | Place value | Description                      |
|--------|--------|--------|-------------|----------------------------------|
| 7 to 6 | -      | -      | -           | unused                           |
| 5 to 4 | HOURS  | 0 to 2 | ten's place | actual hours coded in BCD format |
| 3 to 0 |        | 0 to 9 | unit place  |                                  |

8.4.4 Register Days

Table 12. Days - days register (address 05h) bit description

| Bit    | Symbol              | Value  | Place value | Description                    |
|--------|---------------------|--------|-------------|--------------------------------|
| 7 to 6 | -                   | -      | -           | unused                         |
| 5 to 4 | DAYS <sup>[1]</sup> | 0 to 3 | ten's place | actual day coded in BCD format |
| 3 to 0 |                     | 0 to 9 | unit place  |                                |

[1] The PCF8563 compensates for leap years by adding a 29th day to February if the year counter contains a value which is exactly divisible by 4, including the year 00.

### 8.4.5 Register Weekdays

**Table 13. Weekdays - weekdays register (address 06h) bit description**

| Bit    | Symbol   | Value  | Description   |
|--------|----------|--------|---|
| 7 to 3 | -        | -      | unused  |
| 2 to 0 | WEEKDAYS | 0 to 6 | actual weekday values, see <a href="#">Table 14</a> |

**Table 14. Weekday assignments**

| Day <sup>[1]</sup> | Bit |   |   |
|--------------------|-----|---|---|
|                    | 2   | 1 | 0 |
| Sunday             | 0   | 0 | 0 |
| Monday             | 0   | 0 | 1 |
| Tuesday            | 0   | 1 | 0 |
| Wednesday          | 0   | 1 | 1 |
| Thursday           | 1   | 0 | 0 |
| Friday             | 1   | 0 | 1 |
| Saturday           | 1   | 1 | 0 |

[1] Definition may be re-assigned by the user.

### 8.4.6 Register Century\_months

**Table 15. Century\_months - century flag and months register (address 07h) bit description**

| Bit    | Symbol           | Value            | Place value | Description  |
|--------|------------------|------------------|-------------|--|
| 7      | C <sup>[1]</sup> | 0 <sup>[2]</sup> | -           | indicates the century is x                                     |
|        |                  | 1                | -           | indicates the century is x + 1                                 |
| 6 to 5 | -                | -                | -           | unused   |
| 4      | MONTHS           | 0 to 1           | ten's place | actual month coded in BCD format, see <a href="#">Table 16</a> |
| 3 to 0 |                  | 0 to 9           | unit place  |  |

[1] This bit may be re-assigned by the user.

[2] This bit is toggled when the register Years overflows from 99 to 00.

**Table 16. Month assignments in BCD format**

| Month     | Upper-digit (ten's place) | Digit (unit place) |       |       |       |
|-----------|---------------------------|--------------------|-------|-------|-------|
|           | Bit 4                     | Bit 3              | Bit 2 | Bit 1 | Bit 0 |
| January   | 0                         | 0                  | 0     | 0     | 1     |
| February  | 0                         | 0                  | 0     | 1     | 0     |
| March     | 0                         | 0                  | 0     | 1     | 1     |
| April     | 0                         | 0                  | 1     | 0     | 0     |
| May       | 0                         | 0                  | 1     | 0     | 1     |
| June      | 0                         | 0                  | 1     | 1     | 0     |
| July      | 0                         | 0                  | 1     | 1     | 1     |
| August    | 0                         | 1                  | 0     | 0     | 0     |
| September | 0                         | 1                  | 0     | 0     | 1     |

Table 16. Month assignments ...continued in BCD format

| Month    | Upper-digit (ten's place) | Digit (unit place) |       |       |       |
|----------|---------------------------|--------------------|-------|-------|-------|
|          | Bit 4                     | Bit 3              | Bit 2 | Bit 1 | Bit 0 |
| October  | 1                         | 0                  | 0     | 0     | 0     |
| November | 1                         | 0                  | 0     | 0     | 1     |
| December | 1                         | 0                  | 0     | 1     | 0     |

8.4.7 Register Years

Table 17. Years - years register (08h) bit description

| Bit    | Symbol | Value  | Place value | Description                                    |
|--------|--------|--------|-------------|--|
| 7 to 4 | YEARS  | 0 to 9 | ten's place | actual year coded in BCD format <sup>[1]</sup> |
| 3 to 0 |        | 0 to 9 | unit place  |  |

[1] When the register Years overflows from 99 to 00, the century bit C in the register Century\_months is toggled.

8.5 Setting and reading the time

Figure 7 shows the data flow and data dependencies starting from the 1 Hz clock tick.

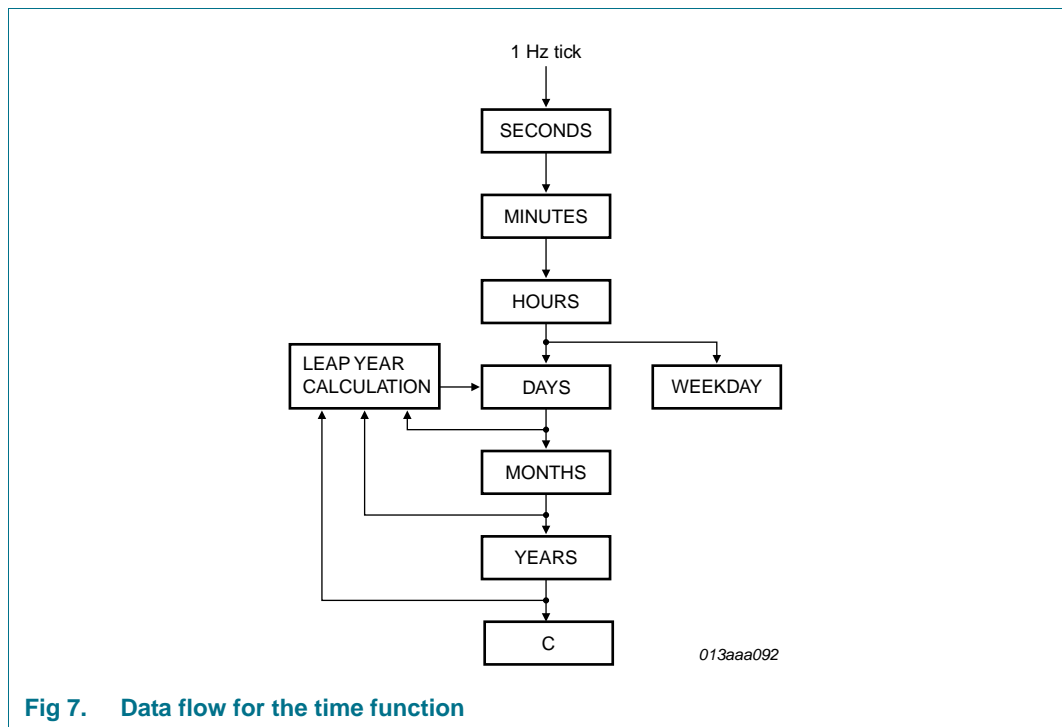


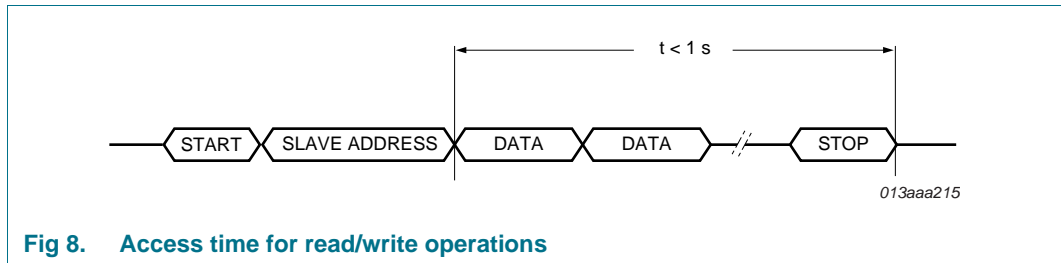
Fig 7. Data flow for the time function

During read/write operations, the time counting circuits (memory locations 02h through 08h) are blocked.

This prevents

- Faulty reading of the clock and calendar during a carry condition
- Incrementing the time registers, during the read cycle

After this read/write access is completed, the time circuit is released again and any pending request to increment the time counters that occurred during the read access is serviced. A maximum of 1 request can be stored; therefore, all accesses must be completed within 1 second (see [Figure 8](#)).



**Fig 8. Access time for read/write operations**

As a consequence of this method, it is very important to make a read or write access in one go, that is, setting or reading seconds through to years should be made in one single access. Failing to comply with this method could result in the time becoming corrupted.

As an example, if the time (seconds through to hours) is set in one access and then in a second access the date is set, it is possible that the time may increment between the two accesses. A similar problem exists when reading. A roll over may occur between reads thus giving the minutes from one moment and the hours from the next.

Recommended method for reading the time:

1. Send a START condition and the slave address for write (A2h).
2. Set the address pointer to 2 (VL\_seconds) by sending 02h.
3. Send a RESTART condition or STOP followed by START.
4. Send the slave address for read (A3h).
5. Read VL\_seconds.
6. Read Minutes.
7. Read Hours.
8. Read Days.
9. Read Weekdays.
10. Read Century\_months.
11. Read Years.
12. Send a STOP condition.

## 8.6 Alarm registers

### 8.6.1 Register Minute\_alarm

**Table 18. Minute\_alarm - minute alarm register (address 09h) bit description**

| Bit    | Symbol       | Value            | Place value | Description                                  |
|--------|--------------|------------------|-------------|--|
| 7      | AE_M         | 0                | -           | minute alarm is enabled                      |
|        |              | 1 <sup>[1]</sup> | -           | minute alarm is disabled                     |
| 6 to 4 | MINUTE_ALARM | 0 to 5           | ten's place | minute alarm information coded in BCD format |
| 3 to 0 |              | 0 to 9           | unit place  |  |

[1] Default value.

### 8.6.2 Register Hour\_alarm

Table 19. Hour\_alarm - hour alarm register (address 0Ah) bit description

| Bit    | Symbol     | Value            | Place value | Description                                |
|--------|------------|------------------|-------------|--|
| 7      | AE_H       | 0                | -           | hour alarm is enabled                      |
|        |            | 1 <sup>[1]</sup> | -           | hour alarm is disabled                     |
| 6      | -          | -                | -           | unused                                     |
| 5 to 4 | HOUR_ALARM | 0 to 2           | ten's place | hour alarm information coded in BCD format |
| 3 to 0 |            | 0 to 9           | unit place  |  |

[1] Default value.

### 8.6.3 Register Day\_alarm

Table 20. Day\_alarm - day alarm register (address 0Bh) bit description

| Bit    | Symbol    | Value            | Place value | Description                               |
|--------|-----------|------------------|-------------|---|
| 7      | AE_D      | 0                | -           | day alarm is enabled                      |
|        |           | 1 <sup>[1]</sup> | -           | day alarm is disabled                     |
| 6      | -         | -                | -           | unused                                    |
| 5 to 4 | DAY_ALARM | 0 to 3           | ten's place | day alarm information coded in BCD format |
| 3 to 0 |           | 0 to 9           | unit place  |   |

[1] Default value.

### 8.6.4 Register Weekday\_alarm

Table 21. Weekday\_alarm - weekday alarm register (address 0Ch) bit description

| Bit    | Symbol        | Value            | Description               |
|--------|---------------|------------------|---------------------------|
| 7      | AE_W          | 0                | weekday alarm is enabled  |
|        |               | 1 <sup>[1]</sup> | weekday alarm is disabled |
| 6 to 3 | -             | -                | unused                    |
| 2 to 0 | WEEKDAY_ALARM | 0 to 6           | weekday alarm information |

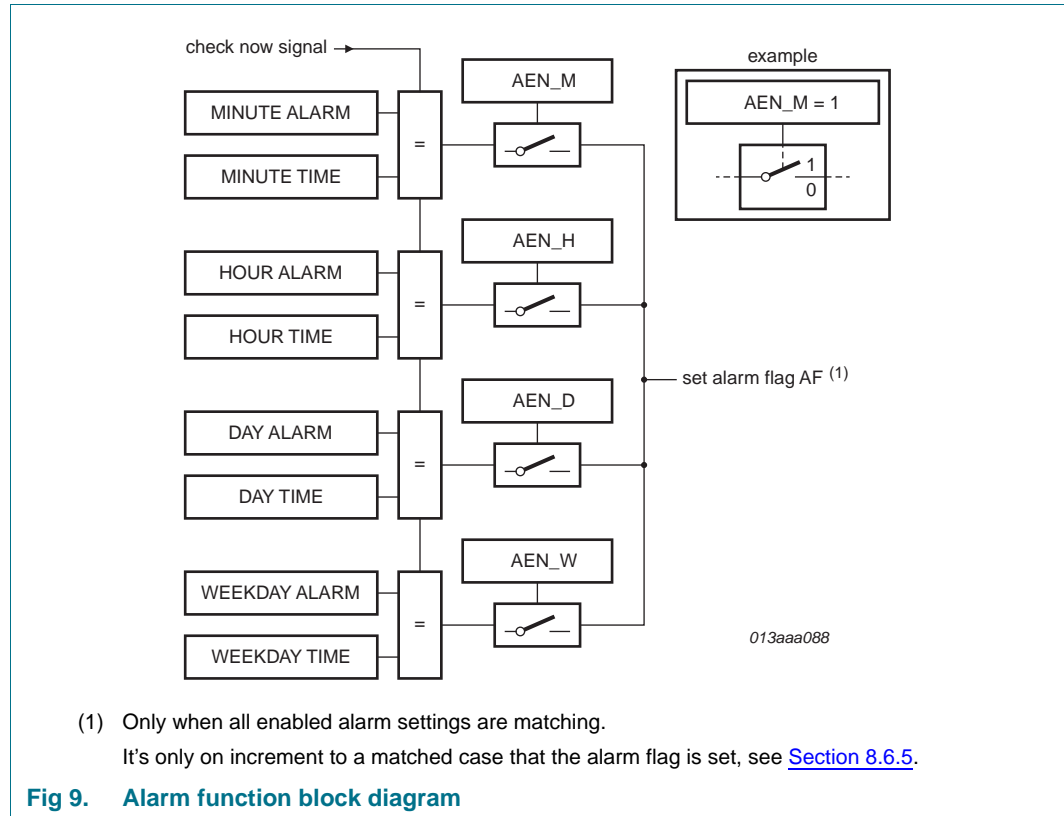
[1] Default value.

### 8.6.5 Alarm flag

By clearing the alarm enable bit (AE\_x) of one or more of the alarm registers, the corresponding alarm condition(s) are active. When an alarm occurs, AF is set to logic 1. The asserted AF can be used to generate an interrupt ( $\overline{\text{INT}}$ ). The AF is cleared using the interface.

The registers at addresses 09h through 0Ch contain alarm information. When one or more of these registers is loaded with minute, hour, day or weekday, and its corresponding AE\_x is logic 0, then that information is compared with the current minute, hour, day, and weekday. When all enabled comparisons first match, the alarm flag (AF in register Control\_2) is set to logic 1.

The generation of interrupts from the alarm function is controlled via bit AIE. If bit AIE is enabled, the  $\overline{\text{INT}}$  pin follows the condition of bit AF. AF will remain set until cleared by the interface. Once AF has been cleared, it will only be set again when the time increments to match the alarm condition once more. Alarm registers which have their AE\_x bit at logic 1 are ignored.



### 8.7 Register CLKOUT\_control and clock output

Frequencies of 32.768 kHz (default), 1.024 kHz, 32 Hz, and 1 Hz can be generated for use as a system clock, microcontroller clock, input to a charge pump, or for calibration of the oscillator.

**Table 22. CLKOUT\_control - CLKOUT control register (address 0Dh) bit description**

| Bit    | Symbol  | Value             | Description  |
|--------|---------|-------------------|--|
| 7      | FE      | 0                 | the CLKOUT output is inhibited and CLKOUT output is set high-impedance |
|        |         | 1 <sup>[1]</sup>  | the CLKOUT output is activated   |
| 6 to 2 | -       | -                 | unused   |
| 1 to 0 | FD[1:0] |                   | frequency output at pin CLKOUT   |
|        |         | 00 <sup>[1]</sup> | 32.768 kHz   |
|        |         | 01                | 1.024 kHz  |
|        |         | 10                | 32 Hz  |
|        |         | 11                | 1 Hz   |

[1] Default value.

### 8.8 Timer function

The 8-bit countdown timer at address 0Fh is controlled by the Timer\_control register at address 0Eh. The Timer\_control register determines one of 4 source clock frequencies for the timer (4096 Hz, 64 Hz, 1 Hz, or 1/60 Hz), and enables or disables the timer. The timer counts down from a software-loaded 8-bit binary value. At the end of every countdown, the timer sets the timer flag TF. The TF may only be cleared by using the interface. The asserted TF can be used to generate an interrupt on pin INT. The interrupt may be generated as a pulsed signal every countdown period or as a permanently active signal which follows the state of TF. Bit TI\_TP is used to control this mode selection. When reading the timer, the current countdown value is returned.

#### 8.8.1 Register Timer\_control

Table 23. Timer\_control - timer control register (address 0Eh) bit description

| Bit    | Symbol  | Value             | Description  |
|--------|---------|-------------------|--|
| 7      | TE      | 0 <sup>[1]</sup>  | timer is disabled                                  |
|        |         | 1                 | timer is enabled                                   |
| 6 to 2 | -       | -                 | unused   |
| 1 to 0 | TD[1:0] |                   | timer source clock frequency select <sup>[2]</sup> |
|        |         | 00                | 4.096 kHz  |
|        |         | 01                | 64 Hz  |
|        |         | 10                | 1 Hz   |
|        |         | 11 <sup>[2]</sup> | 1/60 Hz  |

[1] Default value.

[2] These bits determine the source clock for the countdown timer; when not in use, TD[1:0] should be set to 1/60 Hz for power saving.

#### 8.8.2 Register Timer

Table 24. Timer - timer value register (address 0Fh) bit description

| Bit    | Symbol     | Value      | Description   |
|--------|------------|------------|---|
| 7 to 0 | TIMER[7:0] | 00h to FFh | countdown period in seconds:<br><br>$CountdownPeriod = \frac{n}{SourceClockFrequency}$ where n is the countdown value |

Table 25. Timer register bits value range

| Bit |    |    |    |   |   |   |   |
|-----|----|----|----|---|---|---|---|
| 7   | 6  | 5  | 4  | 3 | 2 | 1 | 0 |
| 128 | 64 | 32 | 16 | 8 | 4 | 2 | 1 |

The register Timer is an 8-bit binary countdown timer. It is enabled and disabled via the Timer\_control register bit TE. The source clock for the timer is also selected by the Timer\_control register. Other timer properties such as interrupt generation are controlled via the register Control\_status\_2.

For accurate read back of the count down value, it is recommended to read the register twice and check for consistent results, since it is not possible to freeze the countdown timer counter during read back.



## 8.9 EXT\_CLK test mode

A test mode is available which allows for on-board testing. In such a mode it is possible to set up test conditions and control the operation of the RTC.

The test mode is entered by setting bit TEST1 in register Control\_status\_1. Then pin CLKOUT becomes an input. The test mode replaces the internal 64 Hz signal with the signal applied to pin CLKOUT. Every 64 positive edges applied to pin CLKOUT will then generate an increment of one second.

The signal applied to pin CLKOUT should have a minimum pulse width of 300 ns and a maximum period of 1000 ns. The internal 64 Hz clock, now sourced from CLKOUT, is divided down to 1 Hz by a  $2^6$  divide chain called a prescaler. The prescaler can be set into a known state by using bit STOP. When bit STOP is set, the prescaler is reset to 0 (STOP must be cleared before the prescaler can operate again).

From a STOP condition, the first 1 second increment will take place after 32 positive edges on CLKOUT. Thereafter, every 64 positive edges will cause a one-second increment.

**Remark:** Entry into EXT\_CLK test mode is not synchronized to the internal 64 Hz clock. When entering the test mode, no assumption as to the state of the prescaler can be made.

### 8.9.1 Operation example:

1. Set EXT\_CLK test mode (Control\_status\_1, bit TEST1 = 1).
2. Set STOP (Control\_status\_1, bit STOP = 1).
3. Clear STOP (Control\_status\_1, bit STOP = 0).
4. Set time registers to desired value.
5. Apply 32 clock pulses to CLKOUT.
6. Read time registers to see the first change.
7. Apply 64 clock pulses to CLKOUT.
8. Read time registers to see the second change.

Repeat steps 7 and 8 for additional increments.

8.10 STOP bit function

The function of the STOP bit is to allow for accurate starting of the time circuits. The STOP bit function will cause the upper part of the prescaler ( $F_2$  to  $F_{14}$ ) to be held in reset and thus no 1 Hz ticks will be generated (see Figure 10). The time circuits can then be set and will not increment until the STOP bit is released (see Figure 11 and Table 26).

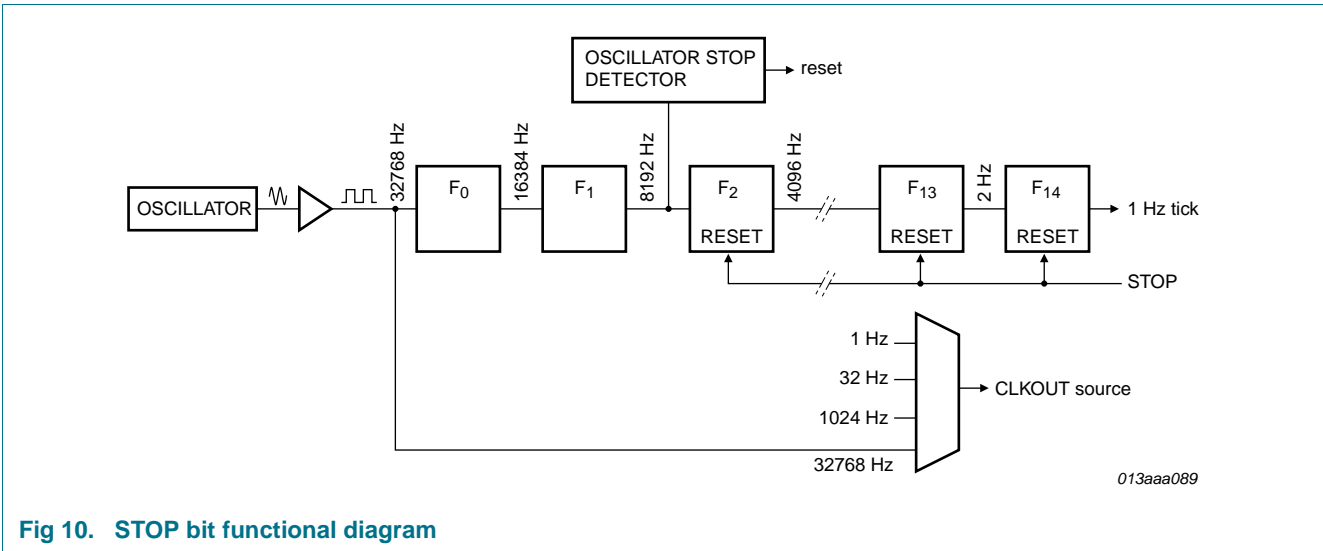


Fig 10. STOP bit functional diagram

The STOP bit function will not affect the output of 32.768 kHz on CLKOUT, but will stop the generation of 1.024 kHz, 32 Hz, and 1 Hz.

The lower two stages of the prescaler ( $F_0$  and  $F_1$ ) are not reset; and because the I<sup>2</sup>C-bus is asynchronous to the crystal oscillator, the accuracy of re-starting the time circuits will be between zero and one 8.192 kHz cycle (see Figure 11).

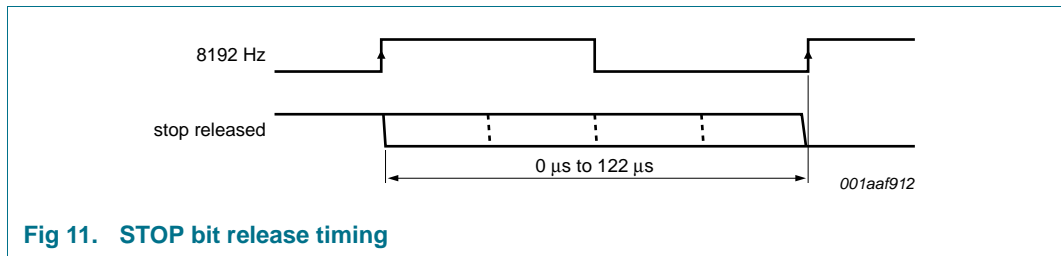


Fig 11. STOP bit release timing

Table 26. First increment of time circuits after STOP bit release

| Bit  | Prescaler bits   | [1] | 1 Hz tick | Time     | Comment   |
|--|--|-----|-----------|----------|---|
| STOP   | F <sub>0</sub> F <sub>1</sub> -F <sub>2</sub> to F <sub>14</sub> |     |           | hh:mm:ss |   |
| <b>Clock is running normally</b>   |  |     |           |          |   |
| 0  | 01-0 0001 1101 0100  |     |           | 12:45:12 | prescaler counting normally                                       |
| <b>STOP bit is activated by user. F<sub>0</sub>F<sub>1</sub> are not reset and values cannot be predicted externally</b> |  |     |           |          |   |
| 1  | XX-0 0000 0000 0000  |     |           | 12:45:12 | prescaler is reset; time circuits are frozen                      |
| <b>New time is set by user</b>   |  |     |           |          |   |
| 1  | XX-0 0000 0000 0000  |     |           | 08:00:00 | prescaler is reset; time circuits are frozen                      |
| <b>STOP bit is released by user</b>  |  |     |           |          |   |
| 0  | XX-0 0000 0000 0000  |     |           | 08:00:00 | prescaler is now running  |
|  | XX-1 0000 0000 0000  |     |           | 08:00:00 | -   |
|  | XX-0 1000 0000 0000  |     |           | 08:00:00 | -   |
|  | XX-1 1000 0000 0000  |     |           | 08:00:00 | -   |
|  | :  |     |           | :        | :   |
|  | 11-1 1111 1111 1110  |     |           | 08:00:00 | -   |
|  | 00-0 0000 0000 0001  |     |           | 08:00:01 | 0 to 1 transition of F <sub>14</sub> increments the time circuits |
|  | 10-0 0000 0000 0001  |     |           | 08:00:01 | -   |
|  | :  |     |           | :        | :   |
|  | 11-1 1111 1111 1111  |     |           | 08:00:01 | -   |
|  | 00-0 0000 0000 0000  |     |           | 08:00:01 | -   |
|  | 10-0 0000 0000 0000  |     |           | 08:00:01 | -   |
|  | :  |     |           | :        | :   |
|  | 11-1 1111 1111 1110  |     |           | 08:00:01 | -   |
|  | 00-0 0000 0000 0001  |     |           | 08:00:02 | 0 to 1 transition of F <sub>14</sub> increments the time circuits |

[1] F<sub>0</sub> is clocked at 32.768 kHz.

The first increment of the time circuits is between 0.507813 s and 0.507935 s after STOP bit is released. The uncertainty is caused by the prescaler bits F<sub>0</sub> and F<sub>1</sub> not being reset (see Table 26) and the unknown state of the 32 kHz clock.

### 8.11 Reset

The PCF8563 includes an internal reset circuit which is active whenever the oscillator is stopped. In the reset state the I<sup>2</sup>C-bus logic is initialized including the address pointer and all registers are set according to Table 27. I<sup>2</sup>C-bus communication is not possible during reset.

Table 27. Register reset value<sup>[1]</sup>

| Address | Register name    | Bit |   |   |   |   |   |   |   |
|---------|------------------|-----|---|---|---|---|---|---|---|
|         |                  | 7   | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 00h     | Control_status_1 | 0   | 0 | 0 | 0 | 1 | 0 | 0 | 0 |
| 01h     | Control_status_2 | 0   | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 02h     | VL_seconds       | 1   | x | x | x | x | x | x | x |
| 03h     | Minutes          | x   | x | x | x | x | x | x | x |
| 04h     | Hours            | x   | x | x | x | x | x | x | x |
| 05h     | Days             | x   | x | x | x | x | x | x | x |
| 06h     | Weekdays         | x   | x | x | x | x | x | x | x |
| 07h     | Century_months   | x   | x | x | x | x | x | x | x |
| 08h     | Years            | x   | x | x | x | x | x | x | x |
| 09h     | Minute_alarm     | 1   | x | x | x | x | x | x | x |
| 0Ah     | Hour_alarm       | 1   | x | x | x | x | x | x | x |
| 0Bh     | Day_alarm        | 1   | x | x | x | x | x | x | x |
| 0Ch     | Weekday_alarm    | 1   | x | x | x | x | x | x | x |
| 0Dh     | CLKOUT_control   | 1   | x | x | x | x | x | 0 | 0 |
| 0Eh     | Timer_control    | 0   | x | x | x | x | x | 1 | 1 |
| 0Fh     | Timer            | x   | x | x | x | x | x | x | x |

[1] Registers marked x are undefined at power-up and unchanged by subsequent resets.

### 8.11.1 Power-On Reset (POR) override

The POR duration is directly related to the crystal oscillator start-up time. Due to the long start-up times experienced by these types of circuits, a mechanism has been built in to disable the POR and hence speed up on-board test of the device. The setting of this mode requires that the I<sup>2</sup>C-bus pins, SDA and SCL, are toggled in a specific order as shown in [Figure 12](#). All timings are required minimums.

Once the override mode has been entered, the device immediately stops, being reset, and normal operation may commence i.e. entry into the EXT\_CLK test mode via I<sup>2</sup>C-bus access. The override mode may be cleared by writing logic 0 to TESTC. TESTC must be set to logic 1 before re-entry into the override mode is possible. Setting TESTC to logic 0 during normal operation has no effect except to prevent entry into the POR override mode.

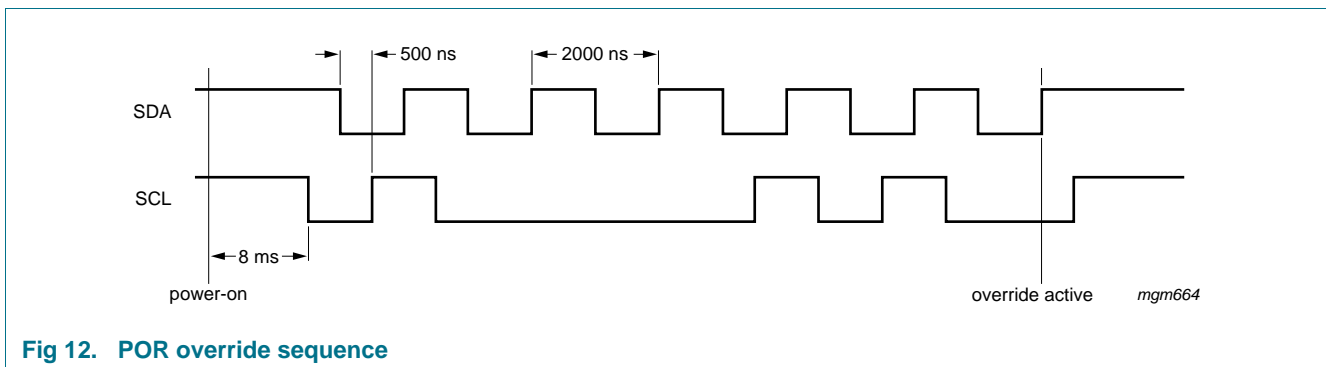


Fig 12. POR override sequence

## 9. Characteristics of the I<sup>2</sup>C-bus

The I<sup>2</sup>C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are a Serial DAta line (SDA) and a Serial CLock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor. Data transfer may be initiated only when the bus is not busy.

### 9.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as a control signal (see [Figure 13](#)).

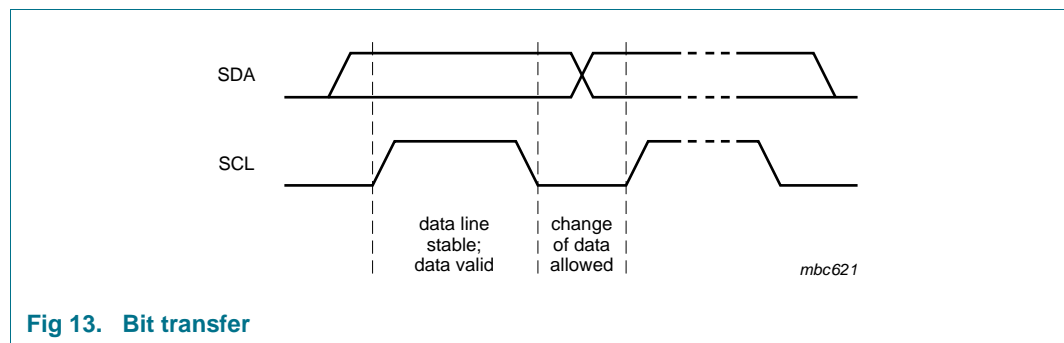


Fig 13. Bit transfer

### 9.2 START and STOP conditions

Both data and clock lines remain HIGH when the bus is not busy.

A HIGH-to-LOW transition of the data line while the clock is HIGH is defined as the START condition - S.

A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition - P (see [Figure 14](#)).

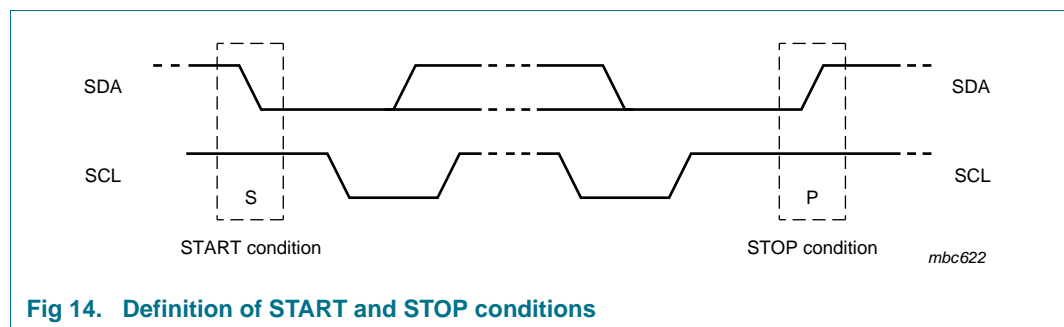


Fig 14. Definition of START and STOP conditions

### 9.3 System configuration

A device generating a message is a transmitter; a device receiving a message is a receiver. The device that controls the message is the master; and the devices which are controlled by the master are the slaves (see [Figure 15](#)).

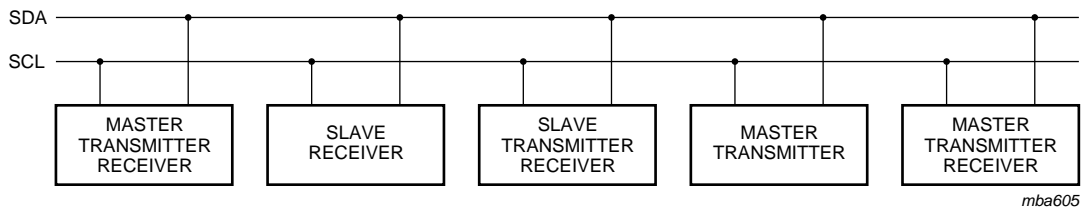


Fig 15. System configuration

### 9.4 Acknowledge

The number of data bytes transferred between the START and STOP conditions from transmitter to receiver is unlimited. Each byte of eight bits is followed by an acknowledge cycle.

- A slave receiver, which is addressed, must generate an acknowledge after the reception of each byte.
- Also a master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter.
- The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be taken into consideration).
- A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.

Acknowledgement on the I<sup>2</sup>C-bus is illustrated in [Figure 16](#).

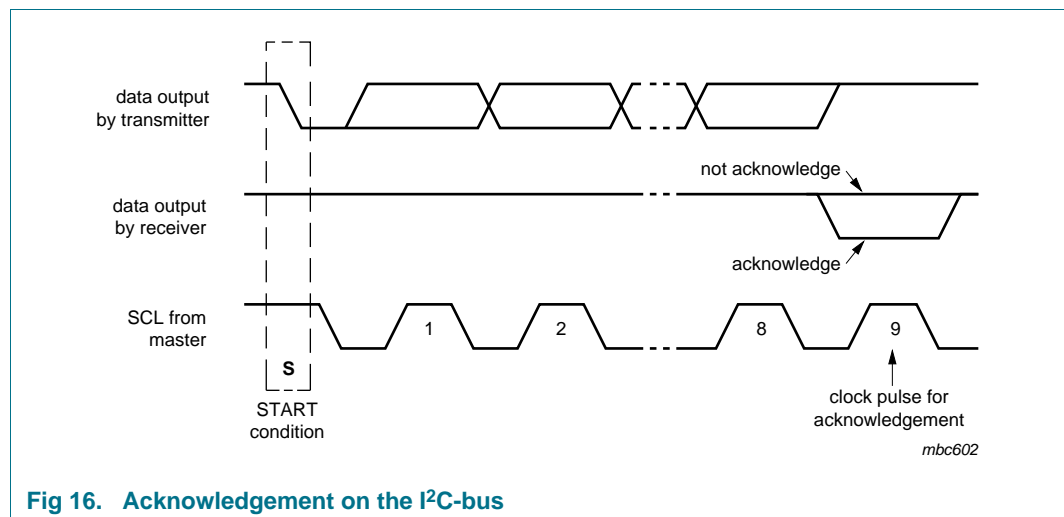


Fig 16. Acknowledgement on the I<sup>2</sup>C-bus

## 9.5 I<sup>2</sup>C-bus protocol

### 9.5.1 Addressing

Before any data is transmitted on the I<sup>2</sup>C-bus, the device which should respond is addressed first. The addressing is always carried out with the first byte transmitted after the start procedure.

The PCF8563 acts as a slave receiver or slave transmitter. Therefore the clock signal SCL is only an input signal, but the data signal SDA is a bidirectional line.

Two slave addresses are reserved for the PCF8563:

Read: A3h (10100011)

Write: A2h (10100010)

The PCF8563 slave address is illustrated in [Figure 17](#).

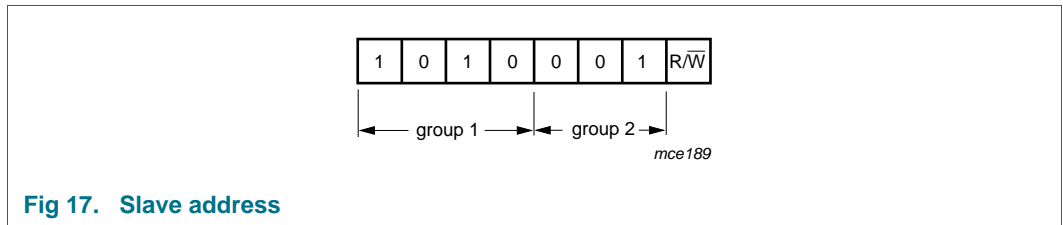


Fig 17. Slave address

### 9.5.2 Clock and calendar READ or WRITE cycles

The I<sup>2</sup>C-bus configuration for the different PCF8563 READ and WRITE cycles is shown in [Figure 18](#), [Figure 19](#) and [Figure 20](#). The register address is a 4-bit value that defines which register is to be accessed next. The upper four bits of the register address are not used.

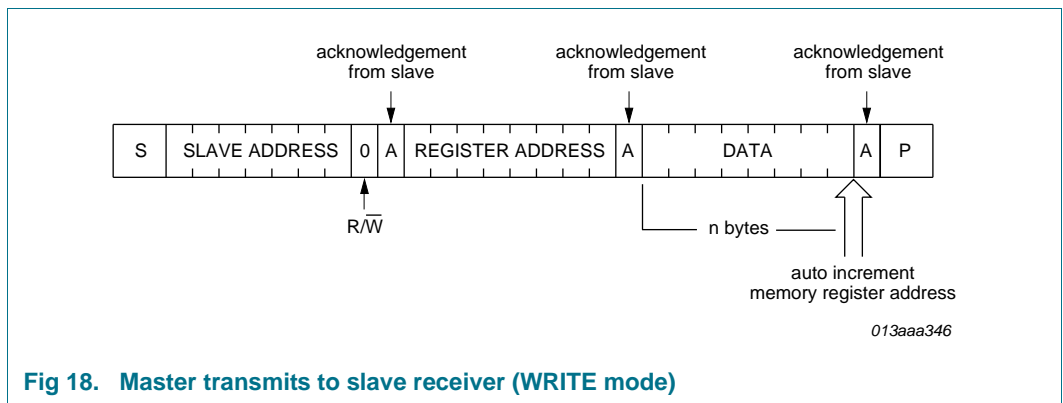
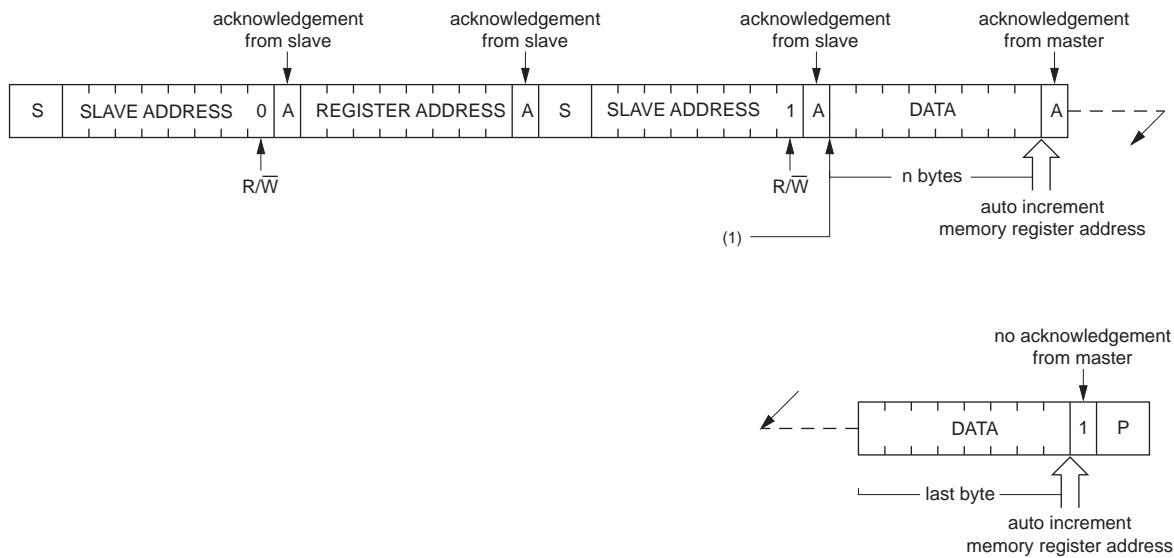
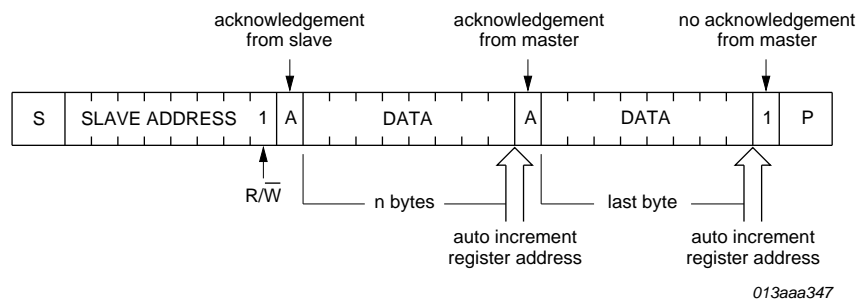


Fig 18. Master transmits to slave receiver (WRITE mode)



(1) At this moment master transmitter becomes master receiver and PCF8563 slave receiver becomes slave transmitter.

**Fig 19. Master reads after setting register address (write register address; READ data)**



**Fig 20. Master reads slave immediately after first byte (READ mode)**



9.6 Interface watchdog timer

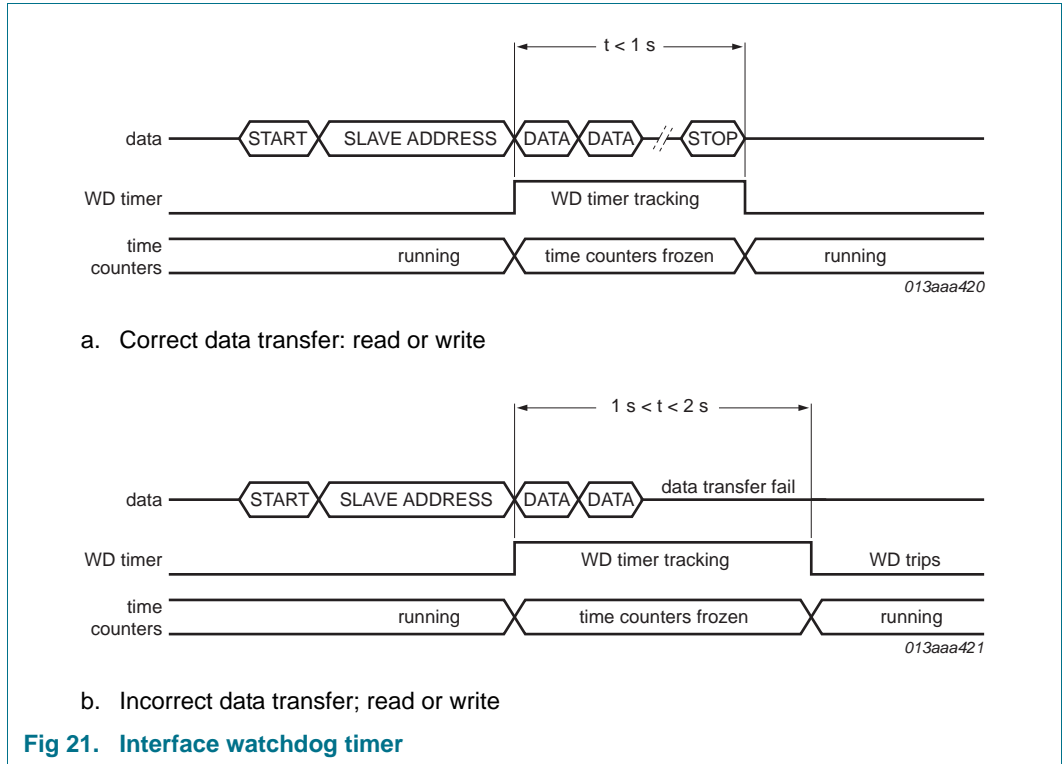


Fig 21. Interface watchdog timer

During read/write operations, the time counting circuits are frozen. To prevent a situation where the accessing device becomes locked and does not clear the interface, the PCF8563 has a built in watchdog timer. Should the interface be active for more than 1 s from the time a valid slave address is transmitted, then the PCF8563 will automatically clear the interface and allow the time counting circuits to continue counting. The watchdog will trigger between 1 s and 2 s after receiving a valid slave address. Each time the watchdog period is exceeded, 1 s will be lost from the time counters.

The watchdog is implemented to prevent the excessive loss of time due to interface access failure e.g. if main power is removed from a battery backed-up system during an interface access.

### 10. Internal circuitry

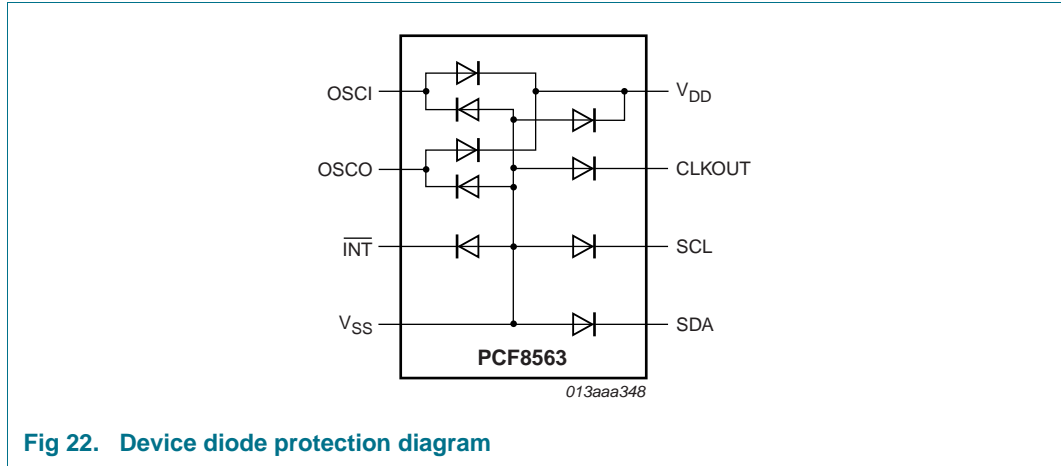


Fig 22. Device diode protection diagram

## 11. Limiting values

**Table 28. Limiting values**
*In accordance with the Absolute Maximum Rating System (IEC 60134).*

| Symbol           | Parameter                       | Conditions                                 | Min  | Max   | Unit |    |
|------------------|---------------------------------|--|------|-------|------|----|
| V <sub>DD</sub>  | supply voltage                  |  | -0.5 | +6.5  | V    |    |
| I <sub>DD</sub>  | supply current                  |  | -50  | +50   | mA   |    |
| V <sub>I</sub>   | input voltage                   | on pins SCL, SDA,<br>and OSC1              | -0.5 | +6.5  | V    |    |
| V <sub>O</sub>   | output voltage                  | on pins CLKOUT and $\overline{\text{INT}}$ | -0.5 | +6.5  | V    |    |
| I <sub>I</sub>   | input current                   | at any input                               | -10  | +10   | mA   |    |
| I <sub>O</sub>   | output current                  | at any output                              | -10  | +10   | mA   |    |
| P <sub>tot</sub> | total power dissipation         |  | -    | 300   | mW   |    |
| V <sub>ESD</sub> | electrostatic discharge voltage | HBM  |      |       |      |    |
|                  |                                 | HVSON10 (PCF8563BS/4) [1]                  | -    | ±3500 | V    |    |
|                  |                                 | SO8 (PCF8563T/F4) [1]                      |      |       |      |    |
|                  |                                 | TSSOP8 (PCF8563TS/4) [1]                   |      |       |      |    |
|                  |                                 | SO8 (PCF8563T/5) [1]                       | -    | ±2000 | V    |    |
|                  |                                 | TSSOP8 (PCF8563TS/5) [1]                   | -    |       |      |    |
|                  |                                 | CDM  |      |       |      |    |
|                  |                                 | HVSON10 (PCF8563BS/4) [2]                  | -    | ±2000 | V    |    |
|                  |                                 | SO8 (PCF8563T/F4) [2]                      | -    | ±1000 | V    |    |
|                  |                                 | SO8 (PCF8563T/5) [2]                       | -    | ±1500 | V    |    |
|                  |                                 | TSSOP8 (PCF8563TS/4) [2]                   | -    | ±1500 | V    |    |
|                  |                                 | TSSOP8 (PCF8563TS/5) [2]                   | -    | ±1750 | V    |    |
| I <sub>lu</sub>  | latch-up current                |  | [3]  | 200   | mA   |    |
| T <sub>stg</sub> | storage temperature             |  | [4]  | -65   | +150 | °C |
| T <sub>amb</sub> | ambient temperature             | operating device                           | -40  | +85   | °C   |    |

[1] Pass level; Human Body Model (HBM), according to [Ref. 5 "JESD22-A114"](#).

[2] Pass level; Charged-Device Model (CDM), according to [Ref. 6 "JESD22-C101"](#).

[3] Pass level; latch-up testing according to [Ref. 7 "JESD78"](#) at maximum ambient temperature (T<sub>amb(max)</sub>).

[4] According to the NXP store and transport requirements (see [Ref. 9 "UM10569"](#)) the devices should be stored at a temperature of +8 °C to +45 °C and a humidity of 25 % to 75 %. For long term storage products deviant conditions are described in that document.

## 12. Static characteristics

**Table 29. Static characteristics**

$V_{DD} = 1.8\text{ V to }5.5\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $T_{amb} = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$ ;  $f_{osc} = 32.768\text{ kHz}$ ; quartz  $R_s = 40\text{ k}\Omega$ ;  $C_L = 8\text{ pF}$ ; unless otherwise specified.

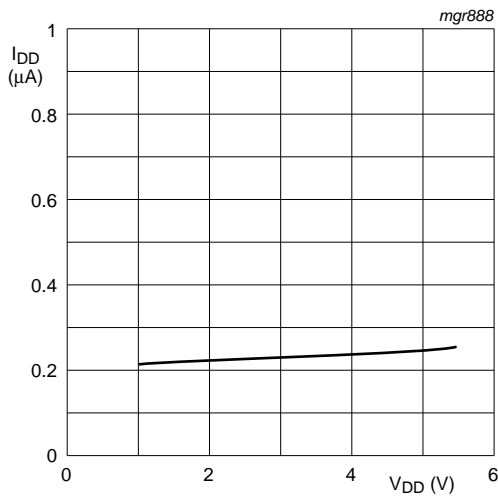
| Symbol                  | Parameter                | Conditions   | Min         | Typ | Max          | Unit          |
|-------------------------|--------------------------|--|-------------|-----|--------------|---------------|
| <b>Supplies</b>         |                          |  |             |     |              |               |
| $V_{DD}$                | supply voltage           | interface inactive; <a href="#">[1]</a><br>$f_{SCL} = 0\text{ Hz}$ ;<br>$T_{amb} = 25\text{ }^{\circ}\text{C}$   | 1.0         | -   | 5.5          | V             |
|                         |                          | interface active;<br>$f_{SCL} = 400\text{ kHz}$  | 1.8         | -   | 5.5          | V             |
|                         |                          | clock data integrity;<br>$T_{amb} = 25\text{ }^{\circ}\text{C}$  | $V_{low}$   | -   | 5.5          | V             |
| $I_{DD}$                | supply current           | interface active   |             |     |              |               |
|                         |                          | $f_{SCL} = 400\text{ kHz}$   | -           | -   | 800          | $\mu\text{A}$ |
|                         |                          | $f_{SCL} = 100\text{ kHz}$   | -           | -   | 200          | $\mu\text{A}$ |
|                         |                          | interface inactive ( $f_{SCL} = 0\text{ Hz}$ ); CLKOUT disabled; $T_{amb} = 25\text{ }^{\circ}\text{C}$ <a href="#">[2]</a>  |             |     |              |               |
|                         |                          | $V_{DD} = 5.0\text{ V}$  | -           | 275 | 550          | nA            |
|                         |                          | $V_{DD} = 3.0\text{ V}$  | -           | 250 | 500          | nA            |
|                         |                          | $V_{DD} = 2.0\text{ V}$  | -           | 225 | 450          | nA            |
|                         |                          | interface inactive ( $f_{SCL} = 0\text{ Hz}$ ); CLKOUT disabled; $T_{amb} = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$ <a href="#">[2]</a>          |             |     |              |               |
|                         |                          | $V_{DD} = 5.0\text{ V}$  | -           | 500 | 750          | nA            |
|                         |                          | $V_{DD} = 3.0\text{ V}$  | -           | 400 | 650          | nA            |
|                         |                          | $V_{DD} = 2.0\text{ V}$  | -           | 400 | 600          | nA            |
|                         |                          | interface inactive ( $f_{SCL} = 0\text{ Hz}$ ); CLKOUT enabled at 32 kHz; $T_{amb} = 25\text{ }^{\circ}\text{C}$ <a href="#">[2]</a>                                 |             |     |              |               |
|                         |                          | $V_{DD} = 5.0\text{ V}$  | -           | 825 | 1600         | nA            |
|                         |                          | $V_{DD} = 3.0\text{ V}$  | -           | 550 | 1000         | nA            |
|                         |                          | $V_{DD} = 2.0\text{ V}$  | -           | 425 | 800          | nA            |
|                         |                          | interface inactive ( $f_{SCL} = 0\text{ Hz}$ ); CLKOUT enabled at 32 kHz; $T_{amb} = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$ <a href="#">[2]</a> |             |     |              |               |
| $V_{DD} = 5.0\text{ V}$ | -                        | 950  | 1700        | nA  |              |               |
| $V_{DD} = 3.0\text{ V}$ | -                        | 650  | 1100        | nA  |              |               |
| $V_{DD} = 2.0\text{ V}$ | -                        | 500  | 900         | nA  |              |               |
| <b>Inputs</b>           |                          |  |             |     |              |               |
| $V_{IL}$                | LOW-level input voltage  |  | -0.5        | -   | $+0.3V_{DD}$ | V             |
| $V_{IH}$                | HIGH-level input voltage |  | $0.7V_{DD}$ | -   | 5.5          | V             |
| $I_{LI}$                | input leakage current    | $V_I = V_{DD}$ or $V_{SS}$   | -1          | 0   | +1           | $\mu\text{A}$ |
| $C_i$                   | input capacitance        | <a href="#">[3]</a>  | -           | -   | 7            | pF            |

**Table 29. Static characteristics ...continued**

$V_{DD} = 1.8\text{ V to }5.5\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $T_{amb} = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$ ;  $f_{osc} = 32.768\text{ kHz}$ ; quartz  $R_s = 40\text{ k}\Omega$ ;  $C_L = 8\text{ pF}$ ; unless otherwise specified.

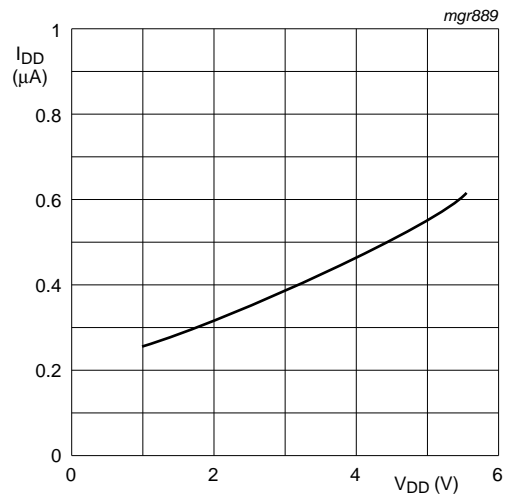
| Symbol                  | Parameter                | Conditions   | Min | Typ | Max | Unit          |
|-------------------------|--------------------------|--|-----|-----|-----|---------------|
| <b>Outputs</b>          |                          |  |     |     |     |               |
| $I_{OL}$                | LOW-level output current | output sink current;<br>$V_{OL} = 0.4\text{ V}$ ; $V_{DD} = 5\text{ V}$            |     |     |     |               |
|                         |                          | on pin SDA   | 3   | -   | -   | mA            |
|                         |                          | on pin $\overline{\text{INT}}$   | 1   | -   | -   | mA            |
|                         |                          | on pin CLKOUT  | 1   | -   | -   | mA            |
| $I_{LO}$                | output leakage current   | $V_O = V_{DD}\text{ or }V_{SS}$  | -1  | 0   | +1  | $\mu\text{A}$ |
| <b>Voltage detector</b> |                          |  |     |     |     |               |
| $V_{low}$               | low voltage              | $T_{amb} = 25\text{ }^{\circ}\text{C}$ ; sets bit VL; see <a href="#">Figure 6</a> | -   | 0.9 | 1.0 | V             |

- [1] For reliable oscillator start-up at power on use  $V_{DD}$  greater than 1.3 V. If powered up at 1.0 V the oscillator will start but it might be a bit slow, especially if at high temperature. Normally the power supply is not 1.0 V at start up and only comes at the end of battery discharge.  $V_{DD}$  min of 1.0 V is specified so that the customer can calculate how large a battery or capacitor they need for their application.  $V_{DD}$  min of 1.3 V or greater is needed to ensure speedy oscillator start-up time.
- [2] Timer source clock =  $1/60$  Hz, level of pins SCL and SDA is  $V_{DD}$  or  $V_{SS}$ .
- [3] Tested on sample basis.



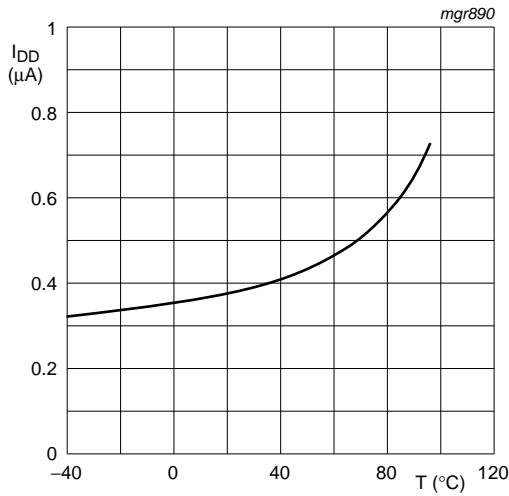
$T_{amb} = 25\text{ }^{\circ}\text{C}$ ; Timer = 1 minute.

**Fig 23. Supply current  $I_{DD}$  as a function of supply voltage  $V_{DD}$ ; CLKOUT disabled**



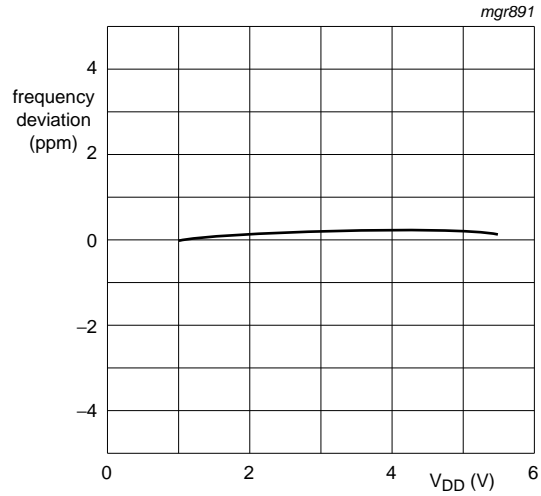
$T_{amb} = 25\text{ }^{\circ}\text{C}$ ; Timer = 1 minute.

**Fig 24. Supply current  $I_{DD}$  as a function of supply voltage  $V_{DD}$ ; CLKOUT = 32 kHz**



V<sub>DD</sub> = 3 V; Timer = 1 minute.

Fig 25. Supply current I<sub>DD</sub> as a function of temperature T; CLKOUT = 32 kHz



T<sub>amb</sub> = 25 °C; normalized to V<sub>DD</sub> = 3 V.

Fig 26. Frequency deviation as a function of supply voltage V<sub>DD</sub>

### 13. Dynamic characteristics

Table 30. Dynamic characteristics

V<sub>DD</sub> = 1.8 V to 5.5 V; V<sub>SS</sub> = 0 V; T<sub>amb</sub> = -40 °C to +85 °C; f<sub>osc</sub> = 32.768 kHz; quartz R<sub>s</sub> = 40 kΩ; C<sub>L</sub> = 8 pF; unless otherwise specified.

| Symbol   | Parameter                                  | Conditions   | Min   | Typ | Max  | Unit |
|--|--|--|-------|-----|------|------|
| <b>Oscillator</b>  |  |  |       |     |      |      |
| C <sub>OSCO</sub>  | capacitance on pin OSCO                    |  | 15    | 25  | 35   | pF   |
| Δf <sub>osc</sub> /f <sub>osc</sub>                                    | relative oscillator frequency variation    | ΔV <sub>DD</sub> = 200 mV;<br>T <sub>amb</sub> = 25 °C | -     | 0.2 | -    | ppm  |
| <b>Quartz crystal parameters (f = 32.768 kHz)</b>                      |  |  |       |     |      |      |
| R <sub>s</sub>   | series resistance                          |  | -     | -   | 100  | kΩ   |
| C <sub>L</sub>   | load capacitance                           | parallel   | [1] 7 | -   | 12.5 | pF   |
| C <sub>trim</sub>  | trimmer capacitance                        | external;<br>on pin OSCI                               | 5     | -   | 25   | pF   |
| <b>CLKOUT output</b>   |  |  |       |     |      |      |
| δ <sub>CLKOUT</sub>  | duty cycle on pin CLKOUT                   |  | [2] - | 50  | -    | %    |
| <b>I<sup>2</sup>C-bus timing characteristics (see Figure 27)[3][4]</b> |  |  |       |     |      |      |
| f <sub>SCL</sub>   | SCL clock frequency                        |  | [5] - | -   | 400  | kHz  |
| t <sub>HD;STA</sub>  | hold time (repeated) START condition       |  | 0.6   | -   | -    | µs   |
| t <sub>SU;STA</sub>  | set-up time for a repeated START condition |  | 0.6   | -   | -    | µs   |
| t <sub>LOW</sub>   | LOW period of the SCL clock                |  | 1.3   | -   | -    | µs   |
| t <sub>HIGH</sub>  | HIGH period of the SCL clock               |  | 0.6   | -   | -    | µs   |
| t <sub>r</sub>   | rise time of both SDA and SCL signals      |  |       |     |      |      |
|  |  | standard-mode  | -     | -   | 1    | µs   |
|  |  | fast-mode  | -     | -   | 0.3  | µs   |

**Table 30. Dynamic characteristics ...continued**

$V_{DD} = 1.8\text{ V to }5.5\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $T_{amb} = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$ ;  $f_{osc} = 32.768\text{ kHz}$ ; quartz  $R_s = 40\text{ k}\Omega$ ;  $C_L = 8\text{ pF}$ ; unless otherwise specified.

| Symbol              | Parameter  | Conditions | Min | Typ | Max | Unit          |
|---------------------|--|------------|-----|-----|-----|---------------|
| $t_f$               | fall time of both SDA and SCL signals            |            | -   | -   | 0.3 | $\mu\text{s}$ |
| $t_{BUF}$           | bus free time between a STOP and START condition |            | 1.3 | -   | -   | $\mu\text{s}$ |
| $C_b$               | capacitive load for each bus line                |            | -   | -   | 400 | pF            |
| $t_{SU;DAT}$        | data set-up time                                 |            | 100 | -   | -   | ns            |
| $t_{HD;DAT}$        | data hold time                                   |            | 0   | -   | -   | ns            |
| $t_{SU;STO}$        | set-up time for STOP condition                   |            | 0.6 | -   | -   | $\mu\text{s}$ |
| $t_w(\text{spike})$ | spike pulse width                                | on bus     | -   | -   | 50  | ns            |

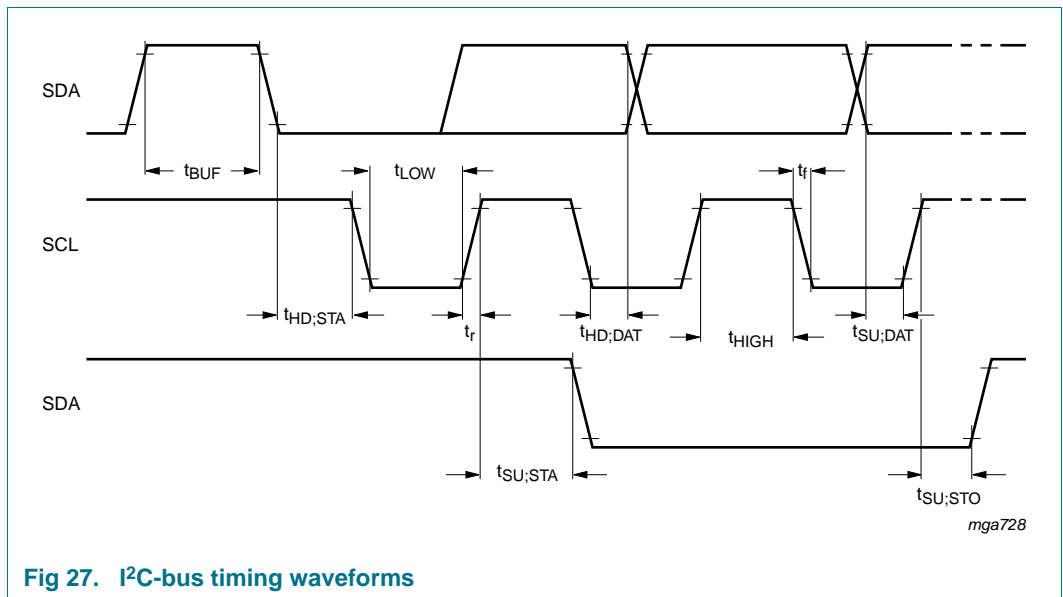
[1]  $C_L$  is a calculation of  $C_{trim}$  and  $C_{OSCO}$  in series:  $C_L = \frac{(C_{trim} \cdot C_{OSCO})}{(C_{trim} + C_{OSCO})}$ .

[2] Unspecified for  $f_{CLKOUT} = 32.768\text{ kHz}$ .

[3] All timing values are valid within the operating supply voltage at ambient temperature and referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ .

[4] A detailed description of the I<sup>2</sup>C-bus specification is given in [Ref. 11 "UM10204"](#).

[5] I<sup>2</sup>C-bus access time between two STARTs or between a START and a STOP condition to this device must be less than one second.



**Fig 27. I<sup>2</sup>C-bus timing waveforms**

## 14. Application information

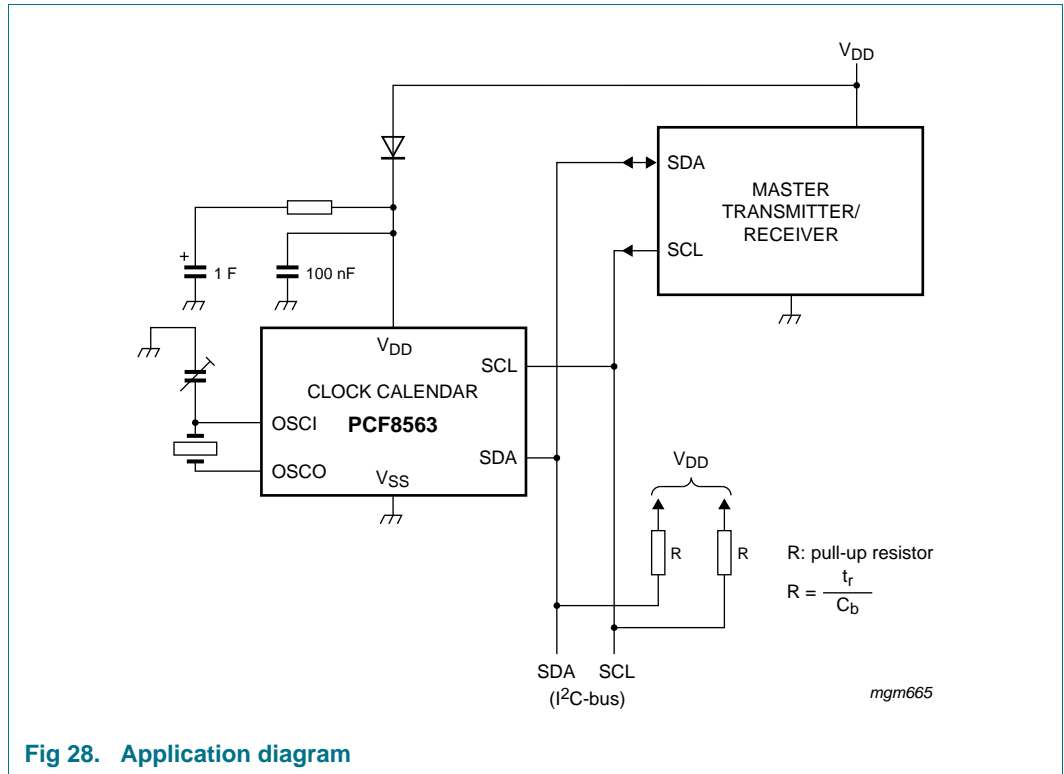


Fig 28. Application diagram

### 14.1 Quartz frequency adjustment

#### 14.1.1 Method 1: fixed OSCI capacitor

By evaluating the average capacitance necessary for the application layout, a fixed capacitor can be used. The frequency is best measured via the 32.768 kHz signal available after power-on at pin CLKOUT. The frequency tolerance depends on the quartz crystal tolerance, the capacitor tolerance and the device-to-device tolerance (on average  $\pm 5$  ppm). Average deviations of  $\pm 5$  minutes per year can be easily achieved.

#### 14.1.2 Method 2: OSCI trimmer

Using the 32.768 kHz signal available after power-on at pin CLKOUT, fast setting of a trimmer is possible.

#### 14.1.3 Method 3: OSCO output

Direct measurement of OSCO out (accounting for test probe capacitance).



### 15. Package outline

HVSON10: plastic thermal enhanced very thin small outline package; no leads;  
10 terminals; body 3 x 3 x 0.85 mm

SOT650-1

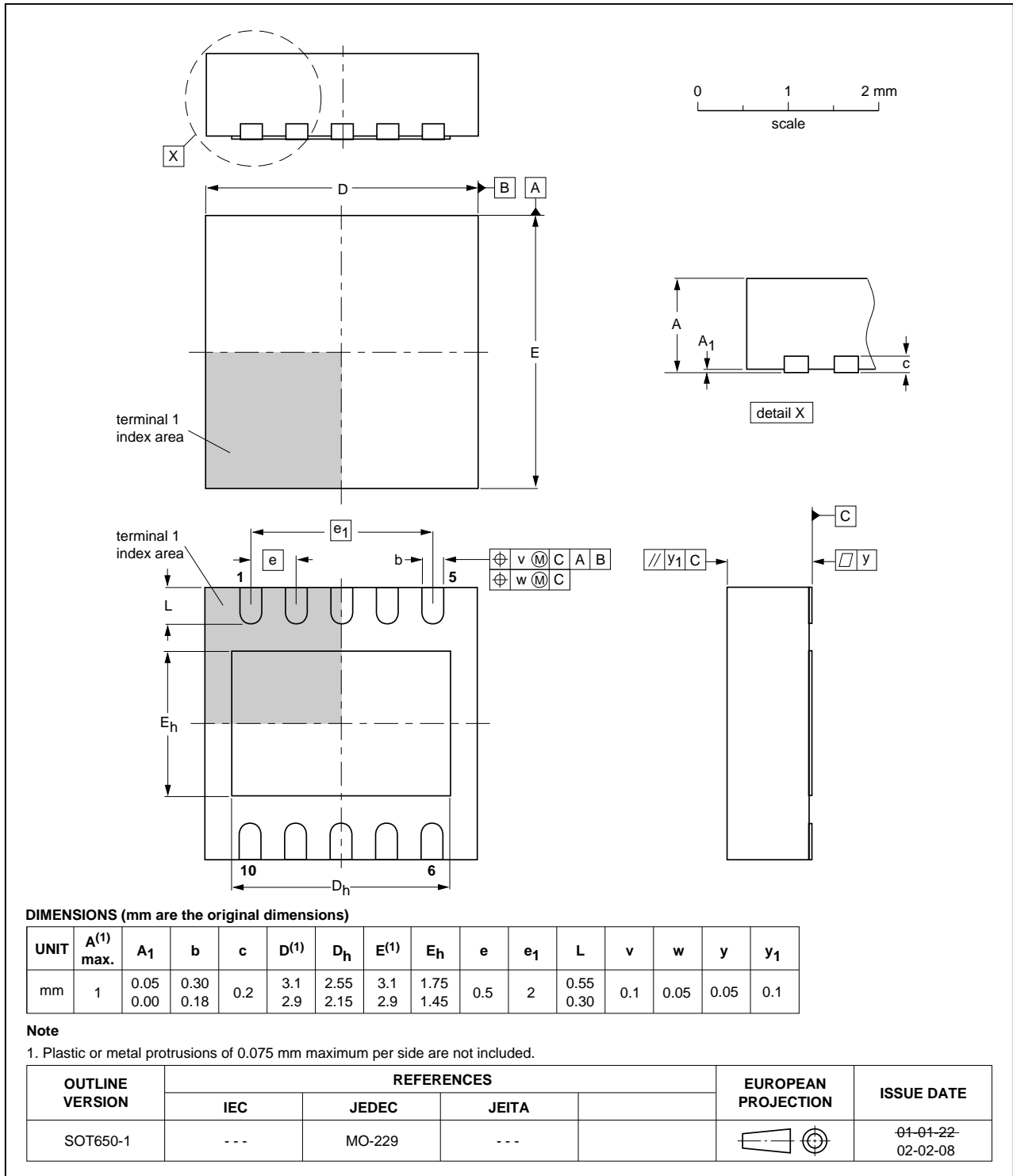


Fig 29. Package outline SOT650-1 (HVSON10) of PCF8563BS

SO8: plastic small outline package; 8 leads; body width 3.9 mm

SOT96-1

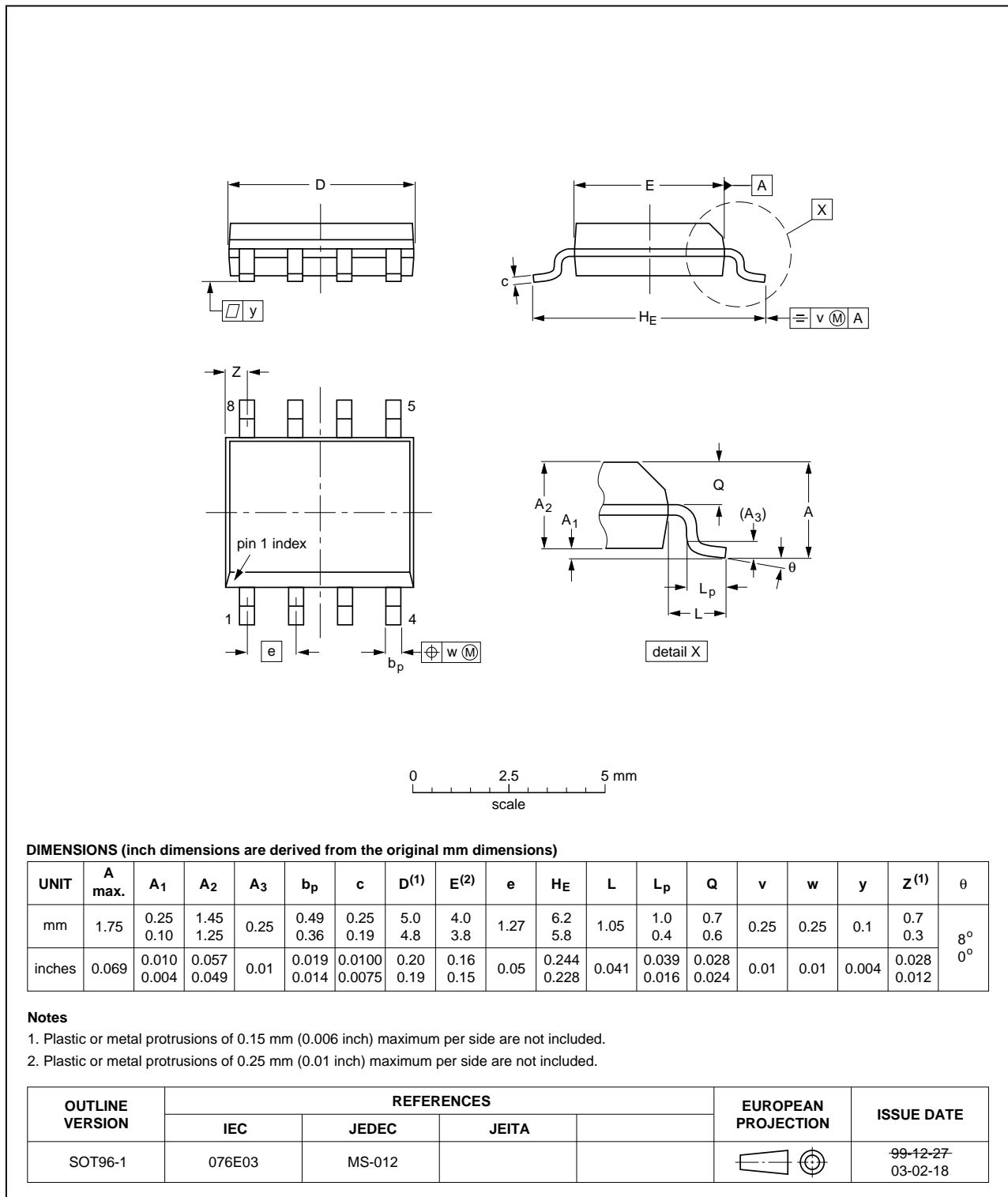


Fig 30. Package outline SOT96-1 (SO8) of PCF8563T

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm

SOT505-1

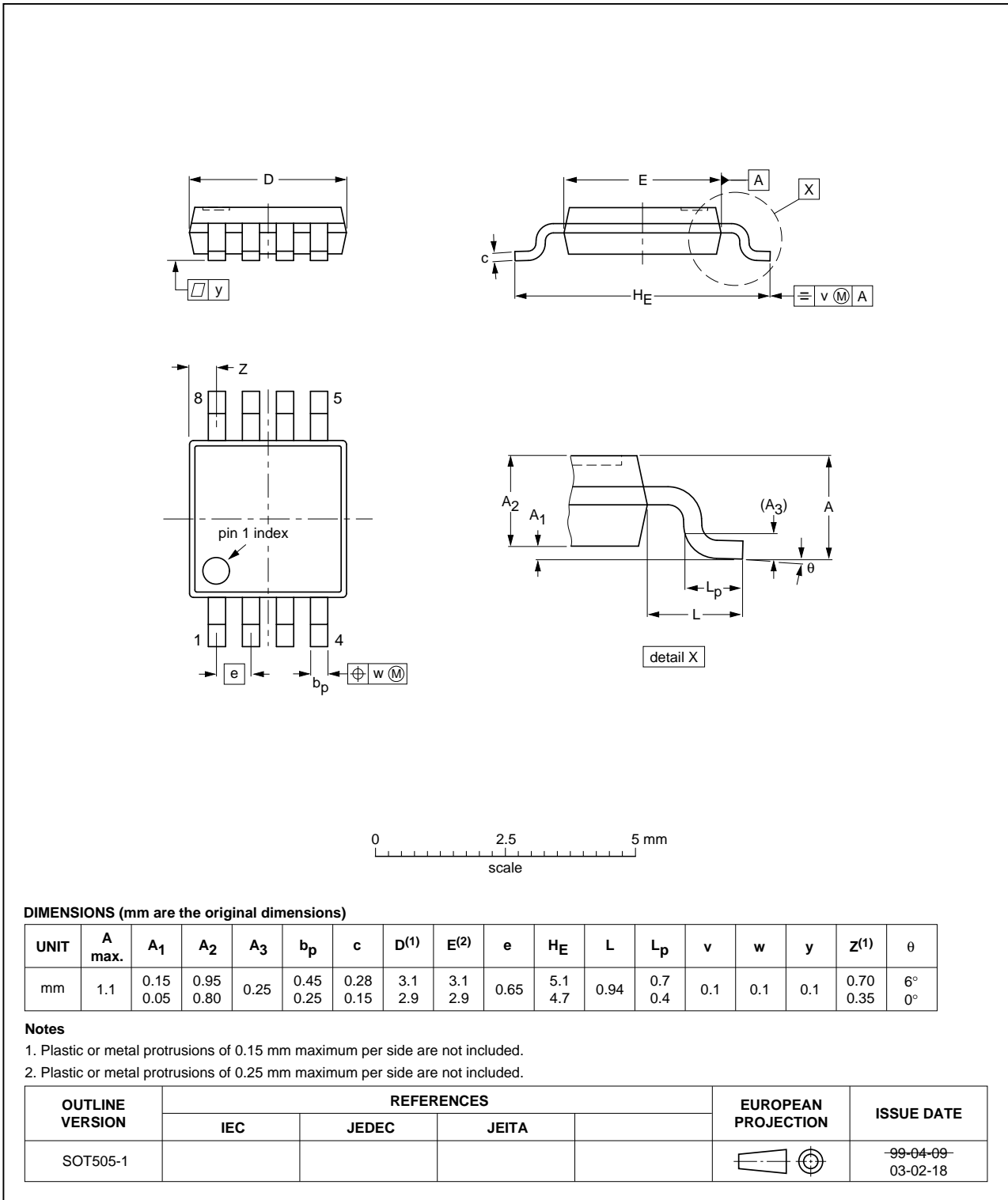


Fig 31. Package outline SOT505-1 (TSSOP8) of PCF8563TS

## 16. Handling information

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All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling Metal-Oxide Semiconductor (MOS) devices ensure that all normal precautions are taken as described in *JESD625-A*, *IEC 61340-5* or equivalent standards.

## 17. Soldering of SMD packages

---

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

### 17.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

### 17.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

### 17.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

### 17.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see [Figure 32](#)) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with [Table 31](#) and [32](#)

**Table 31. SnPb eutectic process (from J-STD-020D)**

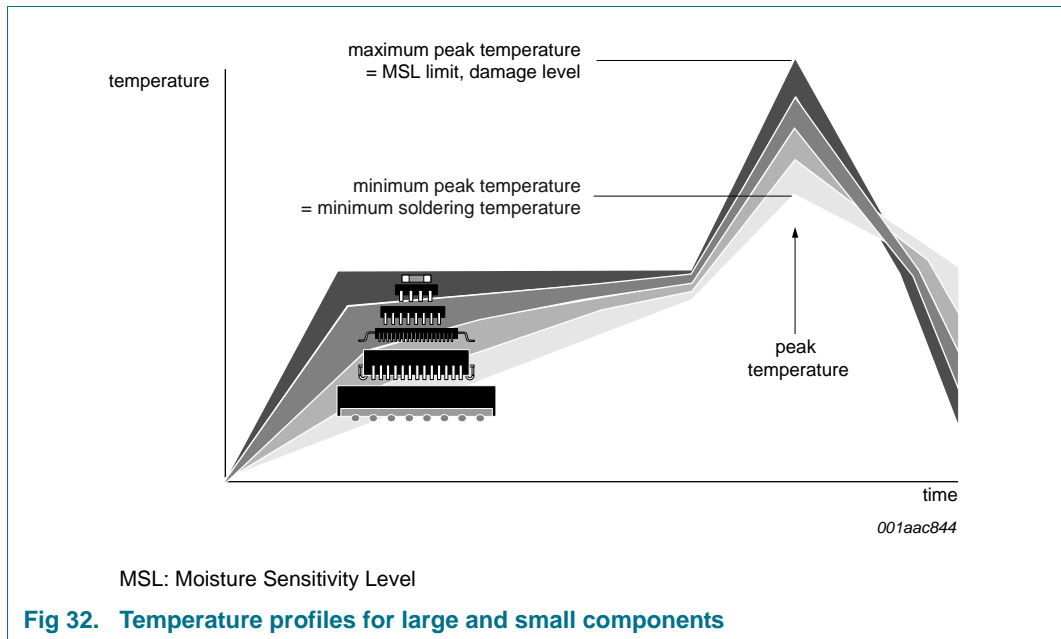
| Package thickness (mm) | Package reflow temperature (°C) |       |
|------------------------|---------------------------------|-------|
|                        | Volume (mm <sup>3</sup> )       |       |
|                        | < 350                           | ≥ 350 |
| < 2.5                  | 235                             | 220   |
| ≥ 2.5                  | 220                             | 220   |

**Table 32. Lead-free process (from J-STD-020D)**

| Package thickness (mm) | Package reflow temperature (°C) |             |        |
|------------------------|---------------------------------|-------------|--------|
|                        | Volume (mm <sup>3</sup> )       |             |        |
|                        | < 350                           | 350 to 2000 | > 2000 |
| < 1.6                  | 260                             | 260         | 260    |
| 1.6 to 2.5             | 260                             | 250         | 245    |
| > 2.5                  | 250                             | 245         | 245    |

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see [Figure 32](#).



For further information on temperature profiles, refer to Application Note AN10365 “Surface mount reflow soldering description”.

## 18. Abbreviations

**Table 33. Abbreviations**

| Acronym          | Description                             |
|------------------|---|
| BCD              | Binary Coded Decimal                    |
| CDM              | Charged-Device Model                    |
| CMOS             | Complementary Metal Oxide Semiconductor |
| ESD              | ElectroStatic Discharge                 |
| HBM              | Human Body Model                        |
| I <sup>2</sup> C | Inter-Integrated Circuit                |
| IC               | Integrated Circuit                      |
| LSB              | Least Significant Bit                   |
| MSB              | Most Significant Bit                    |
| MSL              | Moisture Sensitivity Level              |
| PCB              | Printed-Circuit Board                   |
| POR              | Power-On Reset                          |
| RTC              | Real-Time Clock                         |
| SCL              | Serial CLock line                       |
| SDA              | Serial DATA line                        |
| SMD              | Surface Mount Device                    |

## 19. References

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- [1] **AN10365** — Surface mount reflow soldering description
- [2] **IEC 60134** — Rating systems for electronic tubes and valves and analogous semiconductor devices
- [3] **IEC 61340-5** — Protection of electronic devices from electrostatic phenomena
- [4] **IPC/JEDEC J-STD-020** — Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices
- [5] **JESD22-A114** — Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)
- [6] **JESD22-C101** — Field-Induced Charged-Device Model Test Method for Electrostatic-Discharge-Withstand Thresholds of Microelectronic Components
- [7] **JESD78** — IC Latch-Up Test
- [8] **JESD625-A** — Requirements for Handling Electrostatic-Discharge-Sensitive (ESDS) Devices
- [9] **UM10569** — NXP store and transport requirements
- [10] **SNV-FA-01-02** — Marking Formats Integrated Circuits
- [11] **UM10204** — I<sup>2</sup>C-bus specification and user manual

## 20. Revision history

Table 34. Revision history

| Document ID                     | Release date  | Data sheet status       | Change notice | Supersedes   |
|---------------------------------|---|-------------------------|---------------|--------------|
| PCF8563 v.11                    | 20151026  | Product data sheet      | -             | PCF8563 v.10 |
| Modifications:                  | <ul style="list-style-type: none"> <li>• Removed DIP8 package</li> <li>• <a href="#">Table 3</a>: Corrected <a href="#">Table note 1</a></li> <li>• <a href="#">Table 28</a>, <a href="#">Table note 4</a>: Corrected “the devices have to be stored” to “the devices should be stored”</li> <li>• <a href="#">Table 29</a>: <ul style="list-style-type: none"> <li>– Deleted <a href="#">Table note 1</a> from <math>V_{DD} f_{SCL} = 400</math> kHz</li> <li>– <math>V_{IL}</math>: Corrected <math>V_{SS}</math> to <math>-0.5</math></li> <li>– <math>V_{IH}</math>: Corrected <math>V_{DD}</math> to <math>5.5</math></li> <li>– Corrected <a href="#">Table note 1</a></li> </ul> </li> </ul> |                         |               |              |
| PCF8563 v.10                    | 20120403  | Product data sheet      | -             | PCF8563 v.9  |
| Modifications:                  | <ul style="list-style-type: none"> <li>• Adjusted marking codes</li> <li>• Adjusted text for FE = 0 in <a href="#">Table 22</a></li> </ul>  |                         |               |              |
| PCF8563 v.9                     | 20110616  | Product data sheet      | -             | PCF8563 v.8  |
| PCF8563 v.8                     | 20101118  | Product data sheet      | -             | PCF8563 v.7  |
| PCF8563 v.7                     | 20100723  | Product data sheet      | -             | PCF8563_6    |
| PCF8563_6                       | 20080221  | Product data sheet      | -             | PCF8563_5    |
| PCF8563_5                       | 20070717  | Product data sheet      | -             | PCF8563-04   |
| PCF8563-04<br>(9397 750 12999)  | 20040312  | Product data            | -             | PCF8563-03   |
| PCF8563-03<br>(9397 750 11158)  | 20030414  | Product data            | -             | PCF8563-02   |
| PCF8563-02<br>(9397 750 04855)  | 19990416  | Product data            | -             | PCF8563_N_1  |
| PCF8563_N_1<br>(9397 750 03282) | 19980325  | Objective specification | -             | -            |



## 21. Legal information

### 21.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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